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**NEW UTILITY PATENT APPLICATION TRANSMITTAL**  
**(Large Entity)***(Only for new nonprovisional applications under 37 CFR 1.53(b))*Docket No.  
1048D2Total Pages in this Submission  
65**TO THE ASSISTANT COMMISSIONER FOR PATENTS**Box Patent Application  
Washington, D.C. 20231

Transmitted herewith for filing under 35 U.S.C. 111(a) and 37 C.F.R. 1.53(b) is a new utility patent application for an invention entitled:

**COMPOUNDS AND COMPOSITIONS FOR COATING GLASS WITH SILICON OXIDE**

and invented by:

**George A. Neuman, Patricia Ruzakowski Athey and Royann L. Stewart-Davis****If a CONTINUATION APPLICATION, check appropriate box and supply the requisite information:**☐ Continuation ☒ Divisional ☐ Continuation-in-part (CIP) of prior application No.: 08/678,252

Enclosed are:

**Application Elements**

1. ☒ Filing fee as calculated and transmitted as described below
2. ☒ Specification having 52 pages and including the following:
  - a. ☒ Descriptive Title of the Invention
  - b. ☒ Cross References to Related Applications *(if applicable)*
  - c. ☐ Statement Regarding Federally-sponsored Research/Development *(if applicable)*
  - d. ☐ Reference to Microfiche Appendix *(if applicable)*
  - e. ☒ Background of the Invention
  - f. ☒ Brief Summary of the Invention
  - g. ☒ Brief Description of the Drawings *(if drawings filed)*
  - h. ☒ Detailed Description
  - i. ☒ Claim(s) as Classified Below
  - j. ☒ Abstract of the Disclosure
3. ☒ Drawing(s) *(when necessary as prescribed by 35 USC 113)*
  - a. ☒ Formal
  - b. ☐ Informal

Number of Sheets 4

# NEW UTILITY PATENT APPLICATION TRANSMITTAL (Large Entity)

(Only for new nonprovisional applications under 37 CFR 1.53(b))

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## Application Elements (Continued)

4. ☒ Oath or Declaration
- a. ☐ Newly executed (*original or copy*)      ☐ Unexecuted
- b. ☒ Copy from a prior application (37 CFR 1.63(d)) (*for continuation/divisional application only*)
- c. ☒ With Power of Attorney      ☐ Without Power of Attorney
5. ☐ Incorporation By Reference (*usable if Box 4b is checked*)  
The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.
6. ☐ Computer Program in Microfiche (*Appendix*)
7. ☐ Nucleotide and/or Amino Acid Sequence Submission (*if applicable, all must be included*)
- a. ☐ Paper Copy
- b. ☐ Computer Readable Copy (*identical to computer copy*)
- c. ☐ Statement Verifying Identical Paper and Computer Readable Copy

## Accompanying Application Parts

8. ☐ Assignment Papers (*cover sheet & document(s)*)
9. ☐ 37 CFR 3.73(B) Statement (*when there is an assignee*)
10. ☐ English Translation Document (*if applicable*)
11. ☐ Information Disclosure Statement/PTO-1449      ☐ Copies of IDS Citations
12. ☒ Preliminary Amendment
13. ☒ Acknowledgment postcard
14. ☒ Certificate of Mailing
- ☐ First Class      ☒ Express Mail (*Specify Label No.*): EM276273469US
15. ☐ Certified Copy of Priority Document(s) (*if foreign priority is claimed*)

**NEW UTILITY PATENT APPLICATION TRANSMITTAL**  
**(Large Entity)**

(Only for new nonprovisional applications under 37 CFR 1.53(b))

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**Accompanying Application Parts (Continued)**

16. ☒ Additional Enclosures (please identify below):

Preliminary Amendment Transmittal Letter

**Fee Calculation and Transmittal**

**CLAIMS AS FILED**

| For  | #Filed | #Allowed | #Extra | Rate      | Fee      |
|--|--------|----------|--------|-----------|----------|
| Total Claims   | 1      | - 20 =   | 0      | x \$22.00 | \$0.00   |
| Indep. Claims  | 1      | - 3 =    | 0      | x \$82.00 | \$0.00   |
| Multiple Dependent Claims (check if applicable) <input type="checkbox"/> |        |          |        |           | \$0.00   |
| BASIC FEE  |        |          |        |           | \$790.00 |
| OTHER FEE (specify purpose)  |        |          |        |           | \$0.00   |
| TOTAL FILING FEE   |        |          |        |           | \$790.00 |

- ☐ A check in the amount of \_\_\_\_\_ to cover the filing fee is enclosed.
- ☐ The Commissioner is hereby authorized to charge and credit Deposit Account No. 16-2025 as described below. A duplicate copy of this sheet is enclosed.
- ☒ Charge the amount of \$790.00 as filing fee.
  - ☒ Credit any overpayment.
  - ☒ Charge any additional filing fees required under 37 C.F.R. 1.16 and 1.17.
  - ☐ Charge the issue fee set in 37 C.F.R. 1.18 at the mailing of the Notice of Allowance, pursuant to 37 C.F.R. 1.311(b).
- X Cancel in this application original claims 2-32 of the prior application before calculating the filing fee. (At least one of the original independent claims must be retained for filing purposes.)

Dated: April 9, 1998

  
Signature

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COMPOUNDS AND COMPOSITIONS FOR  
COATING GLASS WITH SILICON OXIDE

CROSS-REFERENCE TO RELATED APPLICATION

5           This application is a continuation-in-part of U.S.  
Application Serial No. 08/264,816 filed June 23, 1994, which  
is a division of U.S. Application Serial No. 08/017,930 filed  
February 16, 1993, now U.S. Patent No. 5,356,718.

10                           BACKGROUND OF THE INVENTION

1.   Field of the Invention

          This invention relates to compounds and  
compositions for the chemical vapor deposition of one or more  
15 metal oxides including silicon oxide on a substrate e.g.  
glass, to silicon containing precursors used in the  
preparation of coating compositions containing silicon oxide  
and other metal oxides, and to the accelerants for enhancing  
the deposition rate of such oxides.

20

2.   Description of the Relevant Art

          It is known in the art that when a film of a  
transparent metal oxide, such as tin oxide, is deposited on a  
glass substrate, the coated glass substrate has non-uniform  
25 light-reflection across the visible spectrum because of the  
difference in the refractive index between the metal oxide and  
the glass substrate. In addition, when the thickness of the  
metal oxide coating is not uniform, the coating tends to  
display a multiplicity of interference color effects commonly  
30 referred to as iridescence. Such iridescence effects render  
the coated glass aesthetically unacceptable for most  
architectural applications. Thus, various methods to mask

such iridescence effects and/or reduce reflectance have been proposed.

One technique for minimizing or eliminating the difference of the refractive index between a metal oxide and a glass substrate is disclosed in U.S. Patent No. 3,378,396 to Zaromb wherein a glass substrate is coated by simultaneously directing separate sprays of a tin chloride solution and of a silicon chloride solution onto a stationary heated glass piece in an oxidizing atmosphere e.g. air. The heat of the glass piece thermally converts the metal chlorides to their metal oxides. The ratio of the sprays to each other are gradually varied to vary the ratio of the weight percent of the metal oxides in the coating. The resultant coating has a continuously-changing composition throughout its thickness, e.g. near the glass-coating interface, the coating is predominantly silicon oxide, the surface of the coating furthest from the glass-coating interface is predominantly tin oxide and there-between the coating is made up of varying weight percent amounts of silicon oxide and tin oxide. Strong in his publication entitled "Practical Applications of High and Low-Reflecting Films on Glass", pages 441-443 of Le Journal de Physique et Le Radium, Vol. 11, July 1950, teaches that a coating technique similar to that taught by Zaromb reduces the iridescence of the coated article.

Additional techniques using the Zaromb teachings to coat a moving substrate are taught in U.S. Patent Nos. 4,206,252 and 4,440,882. These patents further teach the depositing of a second coating composed of fluorine-doped tin oxide on the first coating of the type taught by Zaromb.

Gordon, in U.S. Patent Nos. 4,187,336 and 4,308,316 discloses the reduction of iridescence of a tin oxide coating on a glass substrate by the use of an intermediate coating

between the tin oxide coating and the glass substrate having a thickness and refractive index satisfying the optical equation: the refractive index of the intermediate coating is equal to the square root of the refractive index of the glass substrate times the refractive index of the tin oxide coating.

U.S. Patent Nos. 4,377,613 and 4,419,386 to Gordon disclose a reduction in iridescence arising from a tin oxide film on a glass substrate by providing two intermediate coating layers between the glass substrate and the tin oxide. The intermediate layer next to the surface of the glass substrate has a high refractive index, while the intermediate layer farther from the surface of the glass substrate and next to the tin oxide film has a lower refractive index.

In general, the patents discussed above, except for U.S. Patent Nos. 4,206,252 and 4,440,822, teach coating a stationary glass substrate. Apparatuses for coating a moving glass substrate with metal oxides are disclosed in the above discussed U.S. Patent Nos. 4,206,252 and 4,440,882 to Gordon, and in U.S. Patent No. 4,853,257 to Henery and U.S. Patent No. 4,386,117 to Gordon.

In U.S. Patent Nos. 4,206,252 and 4,440,882, the underside of a moving hot glass ribbon is coated by directing coating compositions containing metal compounds toward the ribbon surface, whose compounds are converted to their corresponding metal oxides.

U.S. Patent No. 4,853,257 discloses an apparatus for depositing a low emissivity film on a glass ribbon by directing metal-containing coating reactants in vapor form onto the upper surface of a glass ribbon while the glass ribbon is supported on a molten metal bath contained in a non-oxidizing atmosphere. The carrier gas, the unreacted coating composition and any decomposition by-products are

removed from the coating zone by an exhaust orifice on each side of, and equidistant from, the position where the coating reactants in vapor form are directed toward the glass ribbon.

U.S. Patent No. 4,386,117 discloses a process for  
5 depositing a mixed metal oxide coating on a glass substrate by directing a gaseous mixture onto a moving glass ribbon and then exhausting gases from the coating zone at two locations equidistant from the entry of the gaseous mixture into the coating zone.

10 Although each of the apparatuses and processes taught in the above-discussed patents is acceptable for its intended purpose, there are limitations when the apparatuses and processes are used to apply the coating of Zaromb to a moving heated glass substrate, e.g. a glass ribbon supported  
15 on a molten metal bath contained in a non-oxidizing atmosphere. It would be advantageous, therefore, to provide apparatuses and processes to deposit the coating of Zaromb on a moving heated substrate as well as the metal containing precursors used in the preparation of the coating.

20 One of the limitations of the presently available vapor coating system for coating a glass ribbon moving at fast speeds e.g. about 600 inches/min. (15.24 meters/min.) is that the vapor coating mixture does not have sufficient time to deposit a coating of acceptable thickness on the glass ribbon.  
25 The article entitled "The LPCVD of Silicon Oxide Films Below 700°F (400°C) From Liquid Sources" by A. K. Hochberg and D. L. O'Meara published in J. Electrochem. Soc. Vol. 136, No. 6, June 1989 copyrighted by The Electrochemical Society, Inc. pps. 1843 and 1844 teaches the use of trimethylphosphite to  
30 accelerate coating deposition below 750°F (400°C). The publication "User's Guide For: Glass Deposition with LTO-410™ Source Material" by Dr. A. Hochberg and Dr. B. Gelernt,

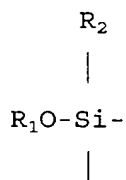
copyrighted 1990 by Schumacher of Carlsbad, California, 92009 teaches that the LTO-410 process is not significantly changed with the addition of trimethylphosphite.

Although the use of accelerants is taught, there  
5 are no teachings that such accelerants are beneficial at elevated temperatures e.g. above 750°F (400°C). Therefore it would be advantageous to provide accelerants for coating systems that operate at temperatures above about 1000°F (536°C).

10

#### SUMMARY OF THE INVENTION

The invention relates to compounds and compositions for coating a moving substrate, e.g. a glass ribbon supported and advancing on a pool of molten metal, e.g. tin, with a film  
15 or coating comprising silicon oxide by directing a vapor coating composition of metal containing precursors, e.g. a silicon-containing precursor and a tin-containing precursor, onto the surface of the glass ribbon. The silicon-containing precursor comprises at least one compound comprising the  
20 structure



25

wherein  $R_1$  is alkyl, alkenyl, alkynyl or aryl radical, and  $R_2$  is hydrogen, halogen, alkenyl, halogenated alkyl, perhalogenated alkyl or alkynyl radical. The silicon-containing precursor may be selected from compounds having one  
30 of the structural formulae:



I



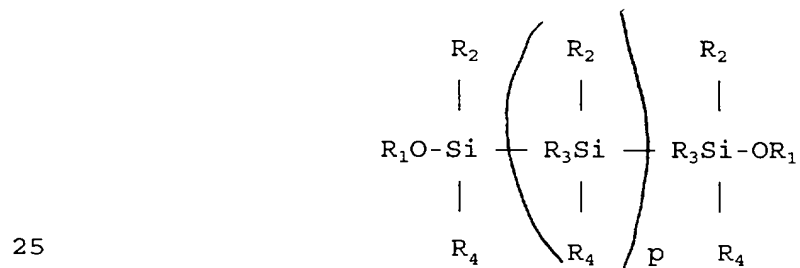
IV



V



VI



wherein m is from 2 to 7, p is from 0 to 7, and R<sub>3</sub> is independently selected from the group consisting of

-S-; -P- and -N-; -O-; and -(CH<sub>2</sub>)-<sub>n</sub>

wherein n is 1 to 10; and  $R_4$  is alkyl, alkenyl, alkynyl, aryl, hydrogen, halogen, -CN, -OCH, and phosphines. The coating composition may further comprise metal-containing precursors of metals other than silicon, e.g. tin compounds, such as organotin compounds. The coating compositions may also comprise an accelerant capable of enhancing the reaction rate of the silicon compound. The accelerants include Lewis acids and Lewis bases, water, ozone and metal compounds.

10

#### BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 illustrates a coated substrate incorporating features of the invention and obtained using the apparatuses, processes, and coating materials of the invention.

15

Figure 2 is an elevation view of a coating system having two coating stations, one of which includes a coating apparatus having multiple coating zones incorporating features of the invention.

20

Figure 3 is a view similar to that of Figure 2 of a coating apparatus having one coating zone incorporating features of the invention.

Figure 4 is a graph showing a gradient coating and an extended and improved gradient coating deposited in accordance with the teachings of the invention.

25

Figure 5 is a graph showing the effect of coating apparatus height from the surface of a glass substrate and carrier flow on the ratio of tin oxide to silicon oxide in the coating deposited on the glass substrate in accordance with the teachings of the invention.

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Figure 6 is a graph showing the effect on film thickness using the accelerants of the instant invention.

DESCRIPTION OF PREFERRED EMBODIMENTS

Referring to Figure 1, there is shown a coated article 10 incorporating features of the invention that can be made using the apparatuses, processes, and coating materials, of the invention. In general, the article 10 includes a substrate 12, e.g. but not limiting to the invention, plastic and/or clear or colored glass, having a coating 14 that exhibits minimum reflected color by having a continually varying refractive index, and preferably has an emissivity lower than the uncoated substrate. In the following discussion the substrate is a glass substrate. The coating 14, in general, is composed of a mixture of silicon oxide and a metal oxide, such as tin oxide. As with Zaromb, discussed above, the coating 14 has a continuously changing composition as the distance from the glass-coating interface 16 increases. Generally, near the glass-coating interface 16, the coating is predominantly silicon oxide, while at the opposite surface 18 of the coating 14 e.g. the coating surface farthest from the glass-coating interface 16, the composition of the coating is predominantly tin oxide. The predominantly tin oxide region may continue as predominantly tin oxide for a thickness required by the use of the article. For example when an article having a high emissivity is desired e.g. close to the emissivity of the glass substrate, the predominantly tin oxide region is thin; when an article having a low emissivity is desired, the predominantly tin oxide region is thicker. The tin oxide region may be doped with fluorine or antimony as taught in U.S. Patent No. 3,677,814 to further reduce emissivity. Between the glass-coating interface 16 and opposite surface 18, the coating 14 is composed of continuously varying amounts of silicon oxide and tin oxide as

the distance from the glass-coating interface 16 increases. In other words, as the distance from the glass-coating interface 16 increases, each succeeding region of the continuously varying composition in the coating 14 contains a tin oxide to silicon oxide weight percent ratio different than the preceding region and although not limiting to the invention, usually that ratio tends to increase as the distance from glass-coating interface 16 increases. The opposite surface 18 is predominantly tin oxide, i.e., the weight percent of silicon oxide in the outermost region approaches zero, and the weight percent of tin oxide approaches 100.

Although the coating 14 was discussed using a coating of tin oxide and silicon oxide, the invention is not limited thereto and as will be appreciated from the discussion below any two or more metal oxides may be used in the practice of the invention.

The coated article 10 of Figure 1 was produced using coating system 19 shown in Figure 2. A discussion of coating apparatus 20 in Figure 3 will now be presented for a better appreciation of the features of the coating system 19 shown in Figure 2. The apparatus 20 of Figure 3 may be used to deposit a non-homogeneous coating of the type discussed above on the glass substrate 12. In Figure 3 as in Figure 2, the substrate 12 is a glass ribbon 22 or pieces cut therefrom.

With reference to Figure 3, coating apparatus 20 is supported in any convenient manner above and spaced from the glass ribbon 22 supported on a pool or bath 24 of molten metal contained in a chamber having a non-oxidizing atmosphere, not shown, e.g. of the type of chamber taught in U.S. Patent No. 4,853,257 whose teachings are hereby incorporated by reference. As viewed in Figure 3, the glass ribbon 22 moves

from left to right beneath the coating apparatus 20 e.g. through a coating position. As will be appreciated the invention is not limited to the chamber, not shown, containing the pool of molten metal, nor to a non-oxidizing atmosphere and any chamber design having any type of atmosphere as well as other processes for moving a heated substrate past a coating apparatus embodying features of the invention may be used in the practice of the invention.

In general and not limiting to the invention, the ribbon 22 has a thickness range from about 0.08 inch to about 0.50 inch (about 2 to about 13 millimeters) and moves at speeds of about 700 to about 100 inches (about 17.80 meters to about 2.54 meters) per minute, respectively. The molten tin bath 24 has a temperature in the range of about 1000°F (538°C) to about 2000°F (1094°C).

The apparatus 20 includes an elongated coating unit 25, two elongated exhausts 28 and 26, one on each side of the coating unit 25, and two elongated discharge units 31 and 32, one on each outboard side of an exhaust as shown in Figure 3. The term "elongated" as used herein means that the coating unit, exhausts and discharge units extend across the width of the ribbon i.e. transverse to the movement of the ribbon 22. The discharge units 31 and 32 provide an inert gas curtain to prevent the coating vapors from the coating zone, i.e. the zone between the discharge units 31 and 32, from moving into the chamber atmosphere and also to prevent the chamber atmosphere from moving into the coating zone. As can be appreciated the separation between the coating zone and chamber atmosphere is required because the atmosphere in the coating zone as will be discussed is an oxidizing atmosphere, and the chamber atmosphere as discussed above is a

non-oxidizing atmosphere. In the practice of the invention, the inert gas was nitrogen.

The exhausts 26 and 28 in accordance with the teachings of the invention are not equally spaced from the coating unit 25. More particularly, with the glass ribbon moving from left to right as shown in Figure 3, the exhaust 28 is closer to the coating unit 25 than the exhaust 26. By positioning the exhausts at different distances from the coating unit the coating vapors are in contact with the ribbon surface for different periods of time. Therefore, all other parameters being equal, e.g., glass temperature, spacing between the coating unit and glass ribbon surface and exhaust pressures, a thicker coating will be deposited on the ribbon as it passes between the exhaust 26 and the coating unit 25, than between the coating unit 25 and the exhaust 28. This feature of the invention will be more fully appreciated in the discussion of the coating system 19 shown in Figure 2.

As can now be appreciated, the design of the discharge units 31 and 32, the exhausts 26 and 28 and coating unit 25 are not limiting to the invention. The invention has been practiced using the exhausts 26 and 28 with an elongated opening 36 connected to a collection chamber 38 and using the discharge units 31 and 32 with an elongated opening 50 connected to a discharge chamber 46. The inert gas has uniform pressure and constant velocity along the length of the opening 50 to provide a curtain of inert gas, a portion of which flows into the chamber (not shown) atmosphere and a portion toward the adjacent exhaust 26 or 28 as shown in Figure 3.

The coating unit 25 includes a discharge chamber 56. The coating vapor exits the chamber 56 by way of elongated opening 58 and is directed toward the surface of the

glass ribbon 22 passing beneath the opening 58. The coating vapor has a uniform pressure and constant velocity along the length of the opening 58 and has sufficient pressure to allow a portion of the coating vapor to flow upstream and a portion to flow downstream as viewed in Figure 3.

The amount of nitrogen typically introduced by each discharge unit 31 and 32 ranges from about 20 to about 300 standard cubic feet per minute for a ribbon having a width of about 160 inches (4.06 meters). As can be appreciated the flow rate of the nitrogen is not limiting to the invention; however, it should be sufficient to provide an inert curtain separating the coating zone and the chamber atmosphere.

The openings 36 of the exhausts 26 and 28 and the exhaust pressure is adjusted to exhaust a portion of the inert gas from the adjacent discharge unit 31 and 32, respectively, and a portion of the coating vapor from the coating unit 25. As seen in Figure 3 and as discussed above, the exhaust 26 is spaced further from the coating unit 25 than the exhaust 28. With this arrangement and maintaining the exhaust pressure the same for each exhaust unit, the coating vapor residence time is greater for the glass ribbon 22 as it moves from the exhaust 26 toward the coater unit 25 than for the glass ribbon as it moves from the coater unit 25 toward the exhaust 28.

Although the above asymmetric arrangement is preferred, because of the simplicity thereof, the invention is not intended to be so bound, since the discovery herein resides in the fact that having different coating vapor residence times on different sides of a coater unit alters the final composition of the coating. Therefore, other apparatuses or processes suitable for obtaining such an effect can be used. It has been determined that the same effect achieved with asymmetrically arranged exhausts, as discussed

above, can also be achieved, even with symmetric spacing of the coating unit 25 and the exhausts by, for example, adjustment of the height or level of the openings 36 of the exhausts 26 and 28 relative to one another and to the glass ribbon. Another method to vary the coating vapor residence time is to vary the ratio of the flow of the exhaust 26 to the exhaust 28.

By way of illustration only, in the instance when the spacing between the coating unit 25 and exhausts 26 and 28 is symmetrical, reducing the pressure of the exhaust 26 below the pressure of the exhaust 28, results in the coating vapor residence time between the coating unit 25 and exhaust 26 being greater than the coating vapor residence time between the coating unit 25 and the exhaust 28.

Referring now to Figure 2, the coating system 19 was used to apply the coating 14 of the coated article 10 shown in Figure 1. The coating system 19 includes a coating station 59 for applying a compositionally graded coating and coating station 60 for extending the thickness of the predominantly tin oxide region at the surface 18 of the coating 14 (see Figure 1). The coating station 59 includes coating units 61, 62 and 64, exhausts 66, 68, 70 and 72 and discharge units 31 and 32. The coating station 60 is not limiting to the invention; however the coating station used in the practice of the invention was the type of coating apparatus disclosed in U.S. Patent No. 4,853,257 which teachings are hereby incorporated by reference. Opening 50 of the discharge unit 31 is spaced about 25 inches (63.5 centimeters) from opening 50 of the discharge unit 32; opening 74 of the exhaust 66 is spaced about 22-1/2 inches (57 centimeters) from the opening 50 of the discharge unit 32; opening 76 of the coating unit 61 is spaced about 20 inches



(51 centimeters) from the opening 50 of the discharge unit 32; opening 78 of the exhaust 68 is spaced 17-1/2 inches (44.5 centimeters) from the opening 50 of the discharge unit 32; opening 80 of the coating unit 62 is spaced about 12-1/2 inches (32 centimeters) from the opening 50 of the discharge unit 32; opening 82 of the exhaust 70 is spaced about 10 inches (25.4 centimeters) from the opening 50 of the discharge unit 32; opening 84 of the coating unit 64 is spaced about 5 inches (12.7 centimeters) from the opening 50 of the discharge unit 32, and opening 86 of the exhaust 72 is spaced about 2-1/2 inches (6 centimeters) from the opening 50 of the discharge unit 32. The coating station 60 was spaced about 6 feet (1.8 meters) from the discharge unit 32.

The openings 50, 74, 76, 78, 80, 82, 84, and 86 were spaced, in a convenient manner, about 0.2 inches (0.51 centimeter) above the upper surface of the glass ribbon 22 as viewed in Figure 2. The length of the openings 50 was about 25 inches (64 centimeters); the length of the openings 74, 78, 82 and 86 was about 25 inches (64 centimeters) and the length of the openings 76, 80 and 84 was about 21 inches (53.34 centimeters). The width of the openings 50 was about 0.125 inch (0.32 centimeter); the width of the openings 74, 78, 82 and 86 was about 0.250 inch (0.64 centimeter) and the width of the openings 76, 80 and 84 was about 0.06 inch (0.15 centimeter). The flows of nitrogen and coating vapor were about 350 to about 700 SLPM (standard liters per minute). The exhaust flow was about 375 to about 770 SLPM. The glass ribbon speeds were between about 200-700 inches (5.08-17.78 meters) per minute, the temperature of the glass ribbon moving into, through and out of the coating stations 59 and 60 was between about 1170-1250°F (635-675°C).

The coating system 19 and in particular the coating station 59 and the method associated therewith are especially effective for the chemical vapor deposition (CVD) of coatings from mixtures of silicon and metal containing precursors to  
5 provide the article 10 shown in Figure 1.

In the following discussion, the coating 14 is made from a mixture of tin containing precursors and silicon containing precursors capable of being volatilized and converted to their corresponding oxides in the presence of  
10 oxygen at temperatures in the range of about 750° to about 1500°F (about 400°C to about 815°C). As will be appreciated the invention is not limited thereto and other metal containing precursors may be used with the coating apparatus and in the coating processes discussed above.

15 Examples of silicon compounds that may be used in the practice of the invention include, but are not limited to, tetraethoxysilane, silane, diethylsilane, di-t-butoxydiacetoxysilane, trichloroethoxysilane, trichloropropoxysilane, ethoxysilane, chloroethoxysilane,  
20 dichloroethoxysilane, tri-(trichloromethyl)ethoxysilane, di-(pentachloroethyl)ethoxysilane, di-(trichloromethyl)ethoxysilane, tri-(pentachloroethyl)ethoxysilane, pentachloroethylethoxysilane, trichloromethylethoxysilane, trichloromethylpropoxysilane,  
25 trichloromethyldichloroethoxysilane, pentachloroethylchloroethoxysilane, dimethylmethoxysilane, dimethylchloromethoxysilane, trichloromethoxysilane, tetramethyldisiloxane, tetramethyldichlorodisiloxane and the silicon compounds disclosed in U.S. Patent No. 3,378,396 to  
30 Zaromb and U.S. Patent Nos. 4,187,336, 4,308,316, 4,377,613, 4,419,386, 4,206,252, 4,440,822, and 4,386,117, which are incorporated herein by reference.

Compounds that have been used in the practice of the invention include diethylsilane, tetramethoxysilane, tetraethoxysilane, tetraisopropoxysilane, diethyldichlorosilane, tetramethylcyclotetrasiloxane and  
5 triethoxysilane.

In addition to the silicon containing precursors discussed above, the invention contemplates silicon containing precursors that can be converted to their corresponding silicon oxides and can be used in admixture with the metal  
10 containing precursors to form the desired coating on a substrate e.g. a glass substrate having a coating with the desired mixed oxide gradient.

Silicon compounds vary in reactivity from silane, with four silicon-hydrogen bonds, which is explosive, to  
15 tetraethoxysilane, with four silicon-oxygen bonds, which is very stable and reacts very slowly. In accordance with the present invention, silicon compounds are selected which are relatively stable in the gas phase prior to forming of the coating, but decompose rapidly at the substrate surface to  
20 form silicon oxide. The present invention provides silicon compounds having the desired degree of reactivity for depositing silicon oxide.

When looking for a silicon containing precursor to form a silicon oxide coating, one skilled in the art would not  
25 normally choose a precursor having an Si-O bond because it is one of the strongest bonds in nature to break, as is evidenced by the stability of the mineral quartz ( $\text{SiO}_2$ ). Therefore breaking the Si-O bond in the precursor and rearranging it into a network lattice containing the silicon oxide bonds  
30 desired for a coating is difficult e.g. the siloxane bond requires high temperature and/or long periods of time to form a corresponding silicon oxide coating. For this reason

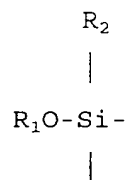
silicon containing precursors having the siloxane structure would not be expected by one skilled in the art to be useful in the formation of a silicon oxide coating on a moving substrate.

5                   It has been determined, however, that if a compound carrying an Si-O bond also carries at least one specific functional group, the reactivity of the silicon containing precursor having the Si-O bond, and therefore its coating formation rate, will be increased, even though the bond  
10 strengths would not seem to indicate any appreciable change in its coating formation behavior. The functional groups that are capable of giving the silicon containing precursor containing an Si-O bond the ability to be easily converted to a silicon oxide coating include hydrogen, halogens, alkynyls,  
15 alkenyls and alpha, beta or gamma-halogenated and perhalogenated alkyls. These functional groups increase the reactivity of the silicon compounds by withdrawing electron density away from the silicon atom and thereby weakening the bond between said functional group and the silicon atom. The  
20 hybridization of the alkene or alkyne bonding results in increased electronegativity relative to the alkanes, which causes the withdrawal of negative electronic charge from the silicon atom. In the case of the halogenated alkyls, the halogens have an inductive effect and are the negative  
25 electron charge withdrawing components. When the halogens are bonded directly to the silicon atom, they withdraw the negative charge directly. The weakened bond is then easier to break thermally under pyrolytic deposition conditions, thereby increasing the deposition rate of silicon oxide. Furthermore,  
30 the activation energy of the reaction, which determines the rate of the reaction, is altered by the functional groups present on the silicon atoms. The increased partial positive

charge on the silicon atom makes it much more susceptible to nucleophilic attack, while the enhanced partial negative charge on the functional group makes the functional group more susceptible to electrophilic attack. This redistribution of the electronic charge and the subsequent enhanced reactivity of the silicon precursors of the instant invention also makes them susceptible to acceleration by compounds that exploit the chemical reactivity imparted by the redistributed electronic charge.

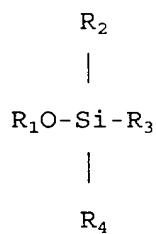
The reaction activation energy is dependent on the path of the reaction. The use of accelerants in the form of electrophiles and nucleophiles assist in altering these reaction pathways by forming lower energy reaction intermediates with the silicon atom and functional groups that boost the overall reaction rate. Such accelerants may also be employed with other precursor compounds that are susceptible to similar electrophilic or nucleophilic attack. The reactivity of the silicon containing precursor can thus be tailored by the appropriate choice of functional groups. The silicon containing precursor of the instant invention is not limited to having only the above-defined substituents thereon. As long as one or more of the above-defined functional groups is present on the silicon containing precursor carrying the Si-O bond, other groups, such as alkyls and other substituents more fully defined below, can also be present without a significant deleterious effect on the overall reactivity of the silicon containing precursor.

Compounds bearing the Si-O bond can be exemplified by reference to the structure

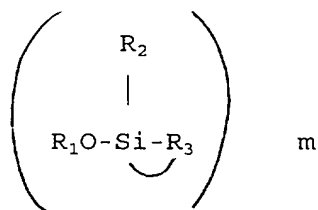


5 which may be present in compounds having the following structural formulae I, IV, V and VI:

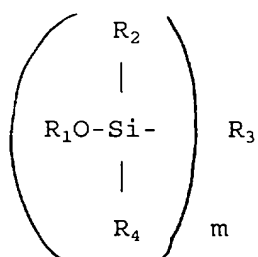
I

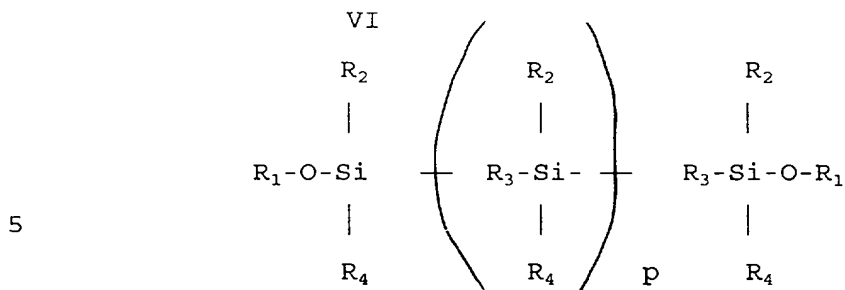


IV



V





wherein m is from 2 to 7; R<sub>1</sub> is selected from the following  
 10 Group A which consists of compounds that do not have an oxygen  
 available to form the peroxide bond:

alkyl, or substituted alkyl, radicals having from 1  
 to 10, preferably 1 to 4, carbon atoms, such as  
 -CH<sub>3</sub>, -CH<sub>2</sub>CH<sub>2</sub>CH<sub>3</sub> and -CH<sub>2</sub>CH<sub>2</sub>OH;

15 halogenated or perhalogenated alkyl radicals having  
 from 1 to 10, preferably 1 to 4, carbon atoms, such as  
 -CCl<sub>3</sub>, -CH<sub>2</sub>CHClCH<sub>3</sub> and -CH<sub>2</sub>CCl<sub>2</sub>CCl<sub>3</sub>;

alkenyl or substituted alkenyl radicals having from  
 2 to 10, preferably 2 to 4, carbon atoms, such as  
 20 -CH=CHCH<sub>3</sub> and -CH=CH<sub>2</sub>;

alkynyl or substituted alkynyl radicals having from  
 2 to 10, preferably 2 to 4, carbon atoms, such as  
 -C≡C-CH<sub>3</sub> and -C≡CH; and

aryl or aralkyl or substituted aryl or aralkyl  
 25 radicals having from 6 to 11, preferably 6 to 9, carbon  
 atoms, such as -C<sub>6</sub>H<sub>5</sub> and -C<sub>6</sub>H<sub>4</sub>CH<sub>3</sub>;

wherein R<sub>2</sub> are functional groups that form a bond with the Si  
 atom which is easily thermally broken e.g. at temperatures  
 between about 200°F-800°F (about 93.5°C-445°C) and preferably  
 30 between about 400°F-700°F (205°C-370°C). The functional group  
 (R<sub>2</sub>) capable of giving the silicon containing precursor the

ability to be easily converted to a silicon oxide coating is selected from Group B consisting of:

hydrogen;

halogen, preferably Cl;

5 alkenyl or substituted alkenyl radicals as defined in Group A for R<sub>1</sub>;

α-halogenated alkyl or perhalogenated alkyl, and

alkynyl or substituted alkynyl radicals as defined in Group A for R<sub>1</sub>;

10 wherein R<sub>3</sub> is a bridging group to provide for multiple silicon atom compounds. R<sub>3</sub> is selected from Group C consisting of:

-N-R<sub>5</sub> and -P-R<sub>5</sub> wherein R<sub>5</sub> is an alkyl or substituted

|                      |

alkyl radical having from 1 to 10, preferably 1 to 4,

15 carbon atoms, such as -CH<sub>2</sub>CH<sub>3</sub> or -CH<sub>2</sub>CH<sub>2</sub>CH<sub>3</sub>;

|

-N-; -P-H; -S-; -P- and -(CH<sub>2</sub>-)<sub>n</sub>

|                      |

20 where n is 1 to 10, preferably 1 to 4, and

wherein R<sub>4</sub> completes the bonding on the foundation silicon atom. R<sub>4</sub> is selected from the Groups A and B above and the following Group D consisting of:

25 alkoxide or substituted alkoxide radicals having from 1 to 10, preferably 1 to 4, carbon atoms, such as -OCH<sub>2</sub>CH<sub>3</sub>;  
alkyl or substituted alkyl radicals having from 1 to 10, preferably 1 to 5, carbon atoms, such as -CH<sub>2</sub>CH<sub>3</sub>;

-CN;

30 -OCN, and

-PH<sub>2</sub>;



alkylphosphines, and dialkylphosphines, wherein the alkyl radical has from 1 to 10, preferably 1 to 4, carbon atoms, such as  $\text{-PHCH}_3$  and  $\text{-P(CH}_2\text{CH}_3)_2$ .

Substituents for Groups A, B and D discussed above, can be selected from following Group E consisting of:

an alkoxide radical having from 1 to 10, preferably 1 to 4, carbon atoms, such as  $\text{-OCH}_2\text{CH}_2\text{CH}_2\text{CH}_3$ ;

an alkyl radical having from 1 to 10, preferably 1 to 4, carbon atoms, such as  $\text{-CH}_2\text{CH}_2\text{CH}_3$ ;

a halogen or a halogenated alkyl radical having from 0 to 10, preferably 0 to 4, carbon atoms, such as Cl or  $\text{-CCl}_3$ ;

an alkenyl radical having from 2 to 10, preferably 2 to 4, carbon atoms, such as  $\text{-CH=CH}_2$ ;

an alkynyl radical having from 2 to 10, preferably 2 to 4, carbon atoms, such as  $\text{-C}\equiv\text{CH}$ ;

an aryl or aralkyl radical having from 6 to 11, preferably 6 to 9, carbon atoms, such as  $\text{-C}_6\text{H}_5$ ;

$\text{-CN}$ ;

$\text{-OCN}$ ;

phosphine, alkylphosphine, and dialkyl phosphine radicals, wherein the alkyl group has from 1 to 10, preferably 1 to 4, carbon atoms, such as  $\text{-PH}_2$ ,  $\text{-PHCH}_3$ ,  $\text{-P(CH}_2\text{CH}_3)_2$ , and

$\text{-OH}$ .

A variety of compounds can be formed from these structural formulae. When a molecule containing a single silicon atom is desired,  $R_3$  can be selected from Groups A, B or D. When multi-silicon atom molecules are desired,  $R_3$  is a bridging group. In the multi-silicon atom molecule case,  $R_3$  connects two silicon atoms directly. When the multi-silicon atom molecules are cyclic,  $R_4$  is not present on any of the silicon atoms. When the multi-silicon molecules are straight

or branched chain molecules, the R<sub>4</sub> groups are present only on the silicon atoms in the terminating position in the chain. When molecules with more than two silicon atoms are desired, the bridging groups, R<sub>3</sub>, can be the same or different. In any  
5 case, where any functional group R appears more than once in a compound formula, each occurrence of R may be independently selected from the appropriate group.

Another type of bonding is possible to create multi-silicon atom molecules with Si-O-Si bonds. In this  
10 case, R<sub>1</sub> is no longer selected from Group A and is instead another silicon bearing group from base structure I with the continued requirement of having an R<sub>2</sub> selected from Group B. The bonding between the silicon bearing groups is chosen so that a direct Si-O-Si bond is formed. If a molecule with more  
15 than two silicon atoms is desired, R<sub>4</sub> is only present on the terminating silicon atoms as described above. R<sub>3</sub> can now be selected from Groups A, B, C or D. By selecting R<sub>3</sub> from Group C we can create multi-silicon atom molecules with different bridging groups, i.e., Si-O-Si-N-Si.

20 As can now be appreciated, simple or complex silicon containing precursors are possible. The only requirement remains that each silicon atom have bonded directly to it an oxygen atom and a functional group selected from Group B.

25 Specific compounds that have been used in the practice of the invention include tetramethylcyclotetra-siloxane, tetramethyldisiloxane and triethoxysilane. Specific compounds that may be used in the practice of the invention, but not limiting thereto, are methyldimethoxysilane,  
30 dimethylmethoxysilane, trimethoxysilane, dimethylchloromethoxysilane, methylchlorodimethoxysilane, chlorotri-methoxysilane, dichlorodimethoxysilane, trichloromethoxy-

silane, triethoxysilylacetylene, trimethylpropynylsilane,  
tetramethyldisiloxane, tetramethyldichlorodisiloxane,  
tetramethylcyclotetrasiloxane, triethoxysilane, chlorotri-  
ethoxysilane, pentachloroethyltriethoxysilane and  
5 vinyltriethoxysilane.

A variety of compounds can be formed from the  
structural formulae I, IV, V and VI. Single silicon atom  
molecules are formed using structure I. The structures IV, V  
and VI constitute multi-silicon atom compounds. Structure IV  
10 represents cyclic multi-silicon atom compounds; structure V  
represents branched multi-silicon atom compounds; and  
structure VI represents linear multi-silicon atom compounds.  
All of these silicon compounds comprise a silicon-oxygen bond  
and the rate enhancing functional groups previously described.  
15 The functional groups for these molecules are independently  
selected from the appropriate group, so that when more than  
one functional group occurs in a compound, each occurrence may  
be different. Examples of compounds using structures I, IV, V  
and VI are: trichloroethoxysilane; trichloropropoxysilane;  
20 ethoxysilane; chloroethoxysilane; dichloroethoxysilane;  
tri(trichloromethyl)ethoxysilane; di-  
(pentachloroethyl)ethoxysilane; di-  
(trichloromethyl)ethoxysilane; tri-  
(pentachloroethyl)ethoxysilane; pentachloroethylethoxysilane;  
25 trichloromethylethoxysilane; trichloromethylpropoxysilane;  
trichloromethyldichloroethoxysilane;  
pentachloroethylchloroethoxysilane; dimethylmethoxysilane;  
dimethylchloromethoxysilane; trichloromethoxysilane;  
tetramethyldisiloxane; tetramethyldichlorodisiloxane; 1,3-  
30 bis(chloromethyl)1,3-diethoxy1,3-dimethyldisilazane; 1,3-  
bis(chloromethyl)1,3-diethoxy1,3-dimethyldisiloxane; 1,3-  
bis(trichloromethyl)1,3-diethoxy1,3-dimethyldisilazane; 1,3-

bis(trichloromethyl)1,3-diethoxy1,3-dimethyldisiloxane;  
1,3,5,7-tetraethoxycyclotetrasiloxane; 1,3,5,7-  
tetraethoxycyclotetrasilazane; 2,5-dimethyl, 2,5-diethoxy,  
2,3-disilaloxacyclopentane; and 1,3,5,7-  
5 tetraethoxycyclotetrasilazane.

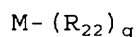
Specific compounds that may be used in the practice  
of the invention, but not limiting thereto, are  
dimethylmethoxysilane, dimethylchloromethoxysilane,  
trichloromethoxysilane, tetramethyldichlorodisiloxane,  
10 trichloroethoxysilane, trichloropropoxysilane, ethoxysilane,  
chloroethoxysilane, dichloroethoxysilane, tri-  
(trichloromethyl)ethoxysilane, di-  
(pentachloroethyl)ethoxysilane, di-  
(trichloromethyl)ethoxysilane, tri-  
15 (pentachloroethyl)ethoxysilane, pentachlorethylethoxysilane,  
trichloromethylethoxysilane, trichloromethylpropoxysilane,  
trichloromethyldichloroethoxysilane,  
pentachloroethylchloroethoxysilane, dimethylmethoxysilane,  
dimethylchloromethoxysilane, trichloromethoxysilane,  
20 tetramethyldisiloxane, and tetramethyldichlorodisiloxane.

Metal containing precursors that can be used in  
admixture with the silicon containing precursors defined above  
in the chemical vapor deposition of mixed oxides on a glass  
substrate include metal containing precursors that are  
25 vaporizable at or below about 500°F (260°C) and that will react  
with an oxygen-containing gas to form the corresponding metal  
oxides. Preferably, but not limiting to the invention,  
compounds that may be used include organometallic compounds  
containing metals including but not limited to titanium,  
30 vanadium, chromium, manganese, iron, cobalt, nickel, copper,  
zinc, gallium, germanium, arsenic, selenium, yttrium,  
zirconium, niobium, molybdenum, cadmium, rhodium, ruthenium,

palladium, indium, antimony, tellurium, tantalum, tungsten, platinum, lead, bismuth, aluminum, and tin. Of these metal compounds, tin, titanium, zinc, antimony, aluminum, tungsten, tantalum, zirconium and indium compounds are most preferred.

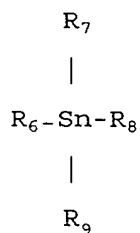
5 Examples of metal compounds useable herein include those defined by the following structural formula VII:

VII



where q is the valence of M, and each R<sub>22</sub> is independently  
10 selected from the group consisting of alkyl, substituted alkyl, halogen, hydrogen, alkoxide, substituted alkoxide, aryl, substituted aryl and acetylacetonate radicals. Of these metal compounds, tin compounds are most preferred. Examples of tin compounds useable herein include those defined by the  
15 following structural formula II:

II



wherein R<sub>6</sub>, R<sub>7</sub>, R<sub>8</sub>, and R<sub>9</sub> are the same or different and include but are not limited to halogens preferably Cl or F, an  
25 alkyl radical having from 1 to 10, preferably 1 to 4, carbon atoms, such as -CH<sub>3</sub>, an aryl group having from 6 to 11, preferably 6 to 9, carbon atoms, such as -C<sub>6</sub>H<sub>5</sub>. In the practice of the invention any other organic or inorganic functional group can be used provided the vapor pressure of  
30 the resultant compound is at least 0.01 pounds per square inch absolute, below about 500°F (260°C).

The silicon containing precursors defined above, including those bearing the Si-O bond, can be used alone, or they can be used in admixture with the organometallic compounds discussed above in the chemical vapor deposition of the corresponding single or mixed oxides on a glass substrate. However, when the silicon containing precursor is used alone, or in admixture with other metal containing precursors, in the chemical vapor deposition of single or mixed oxides onto a moving substrate e.g. coating a ribbon of glass advancing along a molten metal bath or on a conveyor, it is desirable to have a rate of silicon oxide deposition sufficient to coat the moving glass substrate. For example, when coating an advancing glass ribbon and the deposition rate of silicon oxide is relatively low, the glass ribbon speed has to be reduced. More particularly, to deposit about a 1200 Å thick coating on a glass ribbon moving at a line speed of greater than about 300 inches (7.62 meters) per minute, the rate of deposition of all classes of silicon containing precursors used in the chemical vapor deposition processes has to be increased to attain a uniform coating.

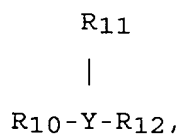
A number of materials have been identified that can be used to accelerate the deposition rate of silicon oxides from their precursors. These accelerants are broadly categorized as electrophiles or nucleophiles, because their purpose is to interact with the electron deficient silicon atom or electron rich functional group of the silicon compounds of the present invention. The capability of the accelerant to lower the activation energy of the deposition reaction makes such accelerants useful in combination with other silicon or metal containing compounds susceptible to electrophilic or nucleophilic attack for the deposition of silicon oxide or other metal oxide. Since the functional

characteristic of the accelerants relates to its electrophilic or nucleophilic capability, broad classes of compounds such as Lewis acids or Lewis bases may be used as accelerants. In addition, metal compounds that behave as Lewis acids or bases, or generate Lewis acids or bases as decomposition products may also be useful as accelerants. The type and functionality of each accelerant depends to some extent on the silicon containing precursors with which it will be used. Combinations have been determined for a specific coated article and for the process used to deposit the desired coating, in particular, the mixed oxide of the invention. It has further been determined that a synergistic effect occurs between certain combinations of precursors and accelerants that result in a beneficial altering and control of the morphology of the coating.

Accelerants that can be used in the practice of the invention to increase the deposition rate of silicon oxide alone or in combination with another oxide, for example, tin oxide or other metal-containing compound, can be defined as follows:

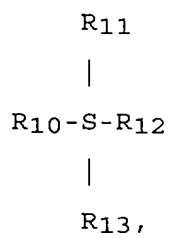
- (1) Lewis Acids, such as trifluoroacetic acid, hydrochloric acid, formic acid and acetic acid.
- (2) Lewis Bases, such as NaOH, NaF, CH<sub>3</sub>OH, CH<sub>3</sub>OCH<sub>3</sub> and S(CH<sub>3</sub>CH<sub>2</sub>)<sub>2</sub>.
- (3) Water.
- (4) Compounds of nitrogen, phosphorus, boron, sulfur and selenium having the following structural formulae:

(a)



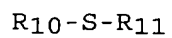
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(b)



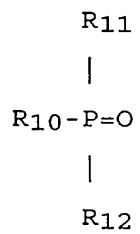
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(c)



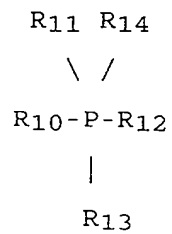
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(d)



20

(e)



25

and

30



(f)



wherein Y is selected from the group consisting of nitrogen, boron and phosphorus and R<sub>10</sub>, R<sub>11</sub>, R<sub>12</sub>, R<sub>13</sub> and R<sub>14</sub> are  
10 selected from the following list of functional groups, hereinafter referred to as Group F:

hydrogen;  
halogens, preferably Cl;  
alkenyl or substituted alkenyl radicals having from  
15 2 to 10, preferably 2 to 4, carbon atoms, such as  
-CH=CH<sub>2</sub>;  
perhalogenated alkyl or substituted alkyl radicals  
having from 1 to 10, preferably 1 to 4, carbon  
atoms, such as -CClH<sub>2</sub> or halogenated alkyl or  
20 substituted alkyl radicals having from 1 to 10,  
preferably 1 to 4, carbon atoms, such as  
-CCl<sub>2</sub>CH<sub>2</sub>CH<sub>3</sub>;  
acyloxy radicals having from 1 to 10, preferably 1  
to 4, carbon atoms, such as -OCOCH<sub>3</sub>;  
25 alkynyl or substituted alkynyl radicals having from  
2 to 10, preferably 2 to 4, carbon atoms, such as  
-C≡CH;  
alkyl or substituted alkyl radicals having from 1  
to 10, preferably 1 to 4, carbon atoms, such as  
30 -CH<sub>3</sub>, -CH<sub>2</sub>CH<sub>2</sub>CH<sub>3</sub>;

aryl or substituted aryl radicals having from 6 to 10, preferably 6 to 9, carbon atoms, such as -C<sub>6</sub>H<sub>4</sub>CH<sub>3</sub>;

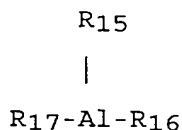
alkoxide or substituted alkoxide radicals having from 1 to 10, preferably 1 to 4, carbon atoms, such as -OCH<sub>2</sub>CH<sub>2</sub>CH<sub>3</sub>;

wherein said substituents are from Group E discussed above,

examples of which compounds include but are not limited to triethylphosphite, trimethylphosphite, trimethylborate, PF<sub>5</sub>, PCl<sub>3</sub>, PBr<sub>3</sub>, PCl<sub>5</sub>, BCl<sub>3</sub>, BF<sub>3</sub>, (CH<sub>3</sub>)<sub>2</sub>BBr, SF<sub>4</sub> and HO<sub>3</sub>SF. In the practice of the invention triethylphosphite was used.

- (5) Compounds of aluminum having the following structural formula III may be used to accelerate the deposition rate of silicon containing precursors alone or in combination with other metal containing precursors (the "other metal containing precursors", as can be appreciated, do not include aluminum containing precursors):

III



wherein R<sub>15</sub>, R<sub>16</sub>, and R<sub>17</sub> are the same or different and are selected from the following Group G: hydrogen;

halogens, preferably Cl;

-O-R<sub>17</sub>, wherein R<sub>17</sub> is a linear, branched or substituted alkyl radical having from 1 to 10

carbon atoms, preferably 1 to 4, with substituents selected from Group E discussed above;

-S-R<sub>18</sub>, where R<sub>18</sub> is equivalent to R<sub>17</sub> defined above;

5 -NH<sub>2</sub>;

R<sub>19</sub>-N-R<sub>20</sub>, wherein R<sub>19</sub> and R<sub>20</sub> are linear or branched alkyl groups, or substituted alkyl groups having from 1 to 10, preferably 1 to 4, carbon atoms, with substituents selected from Group E discussed above; (less the phosphine groups, such as -PH<sub>2</sub>); and

10 N R<sub>21</sub>, wherein R<sub>21</sub> forms cyclic group having from 2 to 10 preferably 2 to 6 carbon atoms, with substituents selected from Group E discussed above (less the phosphine groups).

15 (6) Ozone.

The mechanism that causes the accelerants of the invention to increase the rate of deposition is not completely understood. Even though the mechanism is not completely understood the results, discussed below, clearly demonstrate that the mixed oxide coating deposition rate was increased. With reference to Table 2 in Example I below, Run Nos. 11 and 12 contain the accelerant triethylphosphite. The growth rate of the silicon oxide coating was at least twice the rate of the silicon oxide coating of Run No. 2 that did not have an accelerant.

A moving glass substrate was coated using the same precursor chemistry as used in Run Nos. 11 and 12 of Table 2 and similar deposition rates resulted. The precursors were vaporized at a temperature of about 150°F (65°C) to about 500°F (260°C), and the gaseous mixture of the precursors, oxygen containing gases, and carrier gas and accelerant, were brought

into contact with a glass ribbon supported on a molten metal bath and heated to a temperature of about 950°F (510°C) to about 1350°F (730°C). The glass ribbon advanced at a speed of about 170 to 730 inches (4.25 to 18.00 meters) per minute.

5           The amounts of the components that may be used in the practice of the invention are defined below in Table 1.

Table 1

| 10 | <u>Compound</u>              | <u>Mole Percent</u> |                        |
|----|------------------------------|---------------------|------------------------|
|    |                              | <u>Broad Range</u>  | <u>Preferred Range</u> |
|    | Metal Containing Precursor   | 0.005 to 5.0        | 0.1 to 2.0             |
| 15 | Silicon Containing Precursor | 0.0001 to 5.0       | 0.05 to 2.0            |
|    | Oxygen-Containing Gas        | 1.0 to 99.0         | 5.0 to 50.0            |
|    | Accelerant                   | 0.0001 to 10.00     | 0.01 to 2.0            |

20

When the substrate 12 (see Figure 1) e.g. glass substrate is subjected to chemical vapor deposition of mixed oxides, for example, a mixture of silicon oxide and tin oxide, to obtain the coating 14 thereon in accordance with the process of the invention, the coating 14, as discussed above, is characterized by having a continuously varying composition as the distance from the glass-coating interface 16 increases, resulting in a substantial reduction of iridescence in the coated product. Assuming a coating composed of substantially silicon oxide and tin oxide, that portion of the coating adjacent to the glass-coating interface 16 is composed largely

25

30

of silicon oxide and as the distance from the glass-coating composition increases, each succeeding region of the continuously varying composition contains a silicon oxide to tin oxide ratio that varies as the distance from the glass-coating interface increases. More particularly, the percent of silicon oxide decreases as the percent of tin oxide increases, so that as the opposite surface 18 is reached, the region is composed predominantly of tin oxide. Thereafter the thickness of the region of predominantly tin oxide may be increased to reduce the emissivity of the coated article.

It has been determined that when chemical vapor deposition of mixed oxides on a glass substrate is carried out with the addition of one or more of the accelerants of the instant invention e.g. compounds of phosphorus, aluminum, or boron, a small amount of the foundation atom e.g. phosphorus, aluminum or boron is found dispersed in the coating 14. The presence of phosphorus, aluminum and/or boron in the coating affects the morphology of the resultant coating so that the aforementioned continuously changing components have a decreased probability of forming strata with discrete composition e.g. layers that have a fixed ratio of silicon oxide to tin oxide for thicknesses greater than about 70 Å. Additionally, the presence of phosphorus, aluminum and/or boron affects the morphology of the resultant coating by decreasing the percent crystallinity (approaching 0% crystallinity) and thereby reduces the light scattering properties which can be observed as haze. The amount of the phosphorus, aluminum or boron compound incorporated in the layer is a function of process variables. In the practice of the invention a glass ribbon moving at speeds between 175 to 730 inches (425 to 1800 centimeters) per minute, and having a temperature in the range of 1180°F (637°C) to 1220°F (660°C) was

coated with a gaseous mixture having a phosphorus compound as an accelerant; the mole fraction of the accelerant was 0.01 to 0.5. One to 12 atomic percent of phosphorus was found dispersed in the coating. The invention encompasses using an amount of accelerant greater than 0 and up to 15 atomic percent with a preferred range of 1 to 5 atomic percent.

The present invention will be further appreciated and understood from the description of specific examples which follow:

#### EXAMPLE I

A number of compositions were prepared from silicon containing precursors and monobutyltinchloride to illustrate the increased growth rate of mixed oxide films on a glass substrate in accordance with the teachings of the invention. In each composition, monobutyltinchloride was used with different silicon containing precursors. The precursors were vaporized, when necessary, and the resulting gaseous mixture of precursors, oxygen and nitrogen, were introduced into a quartz tube that was electrically heated and controlled to maintain a temperature of 300°F (150°C). The concentration of the silicon containing precursors was in all instances 0.30 mole percent, the monobutyltinchloride 0.50 mole percent, oxygen 21 mole percent, with the remainder nitrogen. The velocity of the precursors and carrier gas was maintained at a rate of 30 centimeters per second in the quartz tube. This gas mixture was passed over a glass substrate heated to about 1200°F (650°C), for 3 to 30 seconds after which the spent gas mixture was vented into a chemical hood. The film thickness for all the runs except Run No. 8 discussed below was measured using a Tencor P1 profilometer. The film growth rate was

calculated by dividing film thickness by the coating time.  
The data obtained are set forth below in Table 2.

Table 2

|    |                |                                      | Growth Rate,    |
|----|----------------|--------------------------------------|-----------------|
| 5  | <u>Run No.</u> | <u>Silicon Containing Precursors</u> | <u>Å/Second</u> |
|    | 1              | diethylsilane                        | 129             |
|    | 2              | tetraethoxysilane                    | 43              |
|    | 3              | di-t-butoxydiacetosilane             | 64              |
| 10 | 4              | tetramethylcyclotetrasiloxane        | 181             |
|    | 5              | tetramethylcyclotetrasiloxane        | 205             |
|    | 6              | tetramethylcyclotetrasiloxane        | 177             |
|    | 7              | tetramethyldisiloxane                | 164             |
|    | 8              | ethyltriacetoxysilane                | 110*            |
| 15 | 9              | triethoxysilane                      | 139             |
|    | 10             | methyldiacetoxysilane                | 32              |
|    | 11             | tetraethoxysilane + 0.31             |                 |
|    |                | mole percent triethylphosphite       | 136             |
|    | 12             | tetraethoxysilane + 0.09             |                 |
| 20 |                | mole percent triethylphosphite       | 87              |

---

\*estimated

25

Run No. 1 was used as the control because the diethylsilane is generally accepted as having an acceptable rate of deposition.

30 The tetramethylcyclotetrasiloxane precursors used in Run Nos. 4, 5 and 6 were obtained from different suppliers. Run Nos. 2, 3 and 10 using silicon containing precursors

having an Si-O bond without the accelerants or the functional groups of the instant invention had an expected low growth rate. Run Nos. 4, 5, 6, 7 and 9 which had a Si-O bond with the functional group of the instant invention had a deposition  
5 rate equal to or better than the control Run No. 1.

Additionally Run No. 2 when augmented with an accelerator as taught in the instant invention (see Run Nos. 11 and 12) exhibited a deposition rate greater than Run No. 2 and approaching (Run No. 12) or exceeding (Run No. 11) the  
10 deposition rate of control Run No. 1.

Run No. 8 is a compound having the Si-O bond that does not contain a functional group or accelerant of the instant invention; however, it showed a deposition rate equal to the control Run No. 1. The film quality of Run No. 8 was  
15 extremely poor and the film thickness had to be estimated using interference colors which was different from the measuring technique used for Run Nos. 1-7 and 9-12.

#### EXAMPLE II

20 Two runs were carried out showing the advantages obtained using an asymmetric coater configuration of the instant invention in place of a symmetric coater configuration. Referring to Figure 3, in one run the exhausts 26 and 28 were positioned relative to the coating unit 25 such  
25 that  $x/y=2$  where "x" is the distance between the exhaust 28 and the coating unit 25 and "y" is the distance between the coating unit 25 and the exhaust 28, while in the other embodiment, the exhausts 26 and 28 were positioned relative to the coating unit 25 such that  $x/y=1$ . The coating composition  
30 vapor was maintained at 337°F (166°C) and contained 1.2 mole percent monobutyltin chloride, 0.3 mole percent tetraethoxysilane, 0.5 mole percent triethylphosphite, 1.0



mole percent water, 20 mole percent oxygen, and the balance nitrogen. The soda-lime-silica float glass ribbon supported by and moving along a molten metal bath had a thickness of about 0.118 inch (0.300 centimeter), a temperature of about 1200°F (650°C), and a line speed of 510 inches (13 meters) per minute. The surface of the openings of the nitrogen curtain provided by the discharge units 31 and 32 and the exhausts 26 and 28 were maintained at a height of about 0.22 inch (0.55 centimeter) above the surface to be coated of the glass ribbon 2.

The tin depth profile of a film produced on the glass ribbon using both the asymmetric and symmetric coater configurations is shown in the graph in Figure 4. The film analysis was accomplished using the Rutherford Backscattering Spectrometry (RBS) technique for purposes of comparing the gradient film produced by the two coater configurations. The RBS spectra in Figure 4 were taken at a special angle in order to obtain optimum depth resolution of the tin atom distribution through the film.

A comparison of the asymmetric coater configuration (shown by solid line 210) with that of the symmetric coater configuration (shown by dotted line 212) is shown in the RBS spectra in Figure 4. Of significance between the two tin depth profiles 210 and 212 is the extended region of the tin signal from 2025 keV at 3.7 relative counts down to 1890 keV at 1.4 relative counts as compared to the symmetric coater which has its tin signal varying from 2025 KeVC at 3.6 relative counts down to 1940 keV at 1.4 relative counts. This difference shows an increase in film thickness for an asymmetric coater configuration. As can be seen from Figure 4 the asymmetric coater configuration provides the gradient coating with an extended range of varying composition.

EXAMPLE III

A series of runs was carried out using the coating apparatus 20 of Figure 3 where the exhausts 26 and 28 were positioned relative to the coating apparatus 20 such that  $x/y=1$ . The coating composition vapor was maintained at 320°F (165°C) and contained 0.8 mole percent monobutyltinchloride, 0.3 mole percent tetraethoxysilane, 0.1 mole percent triethylphosphite, 0.54 mole percent water, with the balance air. The total gas flow and coater height were varied while the concentrations were held constant. The results obtained are set forth in the process contour chart in Figure 5. By altering coater height in inches and carrier flow in standard liters per minute, the boundary layer conditions are altered in the coating zone thereby altering the relative ratio of tin oxide and silicon oxide deposited. The process contour chart shows how these two other techniques i.e. coater height and volumetric feed, alter the coating composition on the glass substrate.

As shown in Figure 5 increasing the carrier flow for a given coating unit height, increases the ratio of tin oxide to silicon oxide. In other words, the weight percent of tin oxide increases as the weight percent of silicon oxide decreases. Raising the coating unit height for a given carrier flow decreases the ratio of tin oxide to silicon oxide i.e. the weight percent of tin oxide decreases as the weight percent of silicon oxide increases.

EXAMPLE IV

A number of runs were carried out to show the effects of water and triethylphosphite on the thickness of a mixed oxide film at a constant vapor residence time. The

process chart, Figure 6, was developed using experimental design data. The coating unit 25 shown in Figure 3 was used with the exhausts 26 and 28 positioned relative to the coating unit 25 such that  $x/y=1$ . The precursor vapor was maintained at 320°F (165°C) and contained 0.8 mole percent monobutyltinchloride, 0.3 mole percent tetraethoxysilane. Triethylphosphite (TEP) and water were varied and sufficient air was added to obtain a volumetric feed rate of 500 standard liters per minute. The glass ribbon 22 had a thickness of 0.118 inch (0.300 centimeter), a temperature of 1200°F (650°C) and a line speed of 510 inches (13 meters) per minute. The coating unit 25 was maintained at a height of 0.22 inch (0.56 centimeter) above the surface of the glass ribbon. Note the substantial effect exhibited by the presence of triethylphosphite on the coating thickness. As the mole percent of triethylphosphite was increased the coating thickness increased. Increasing the mole percent of the water also increased the coating thickness.

#### EXAMPLE V

The article 12 of Figure 1 was produced using the coating station 59 shown in Figure 2, in conjunction with the coating station 60 described in the teachings of Henery. Coated articles were produced at three glass thicknesses i.e. at three different glass ribbon speeds to demonstrate the flexibility of the process. The coating station 59 was used to produce a coating that varied in composition from predominantly silicon oxide at the glass-coating interface to predominantly pure tin oxide and the coating station 60 produced an extended thickness of predominantly tin oxide.

The coating station 59 had three coating units 61, 62 and 64 with openings 76, 80 and 84 respectively, and four

exhausts 66, 68, 70 and 72. The exhausts 66 and 68 were positioned relative to the coating unit 61 in a symmetric configuration while the exhausts 68 and 70 and the exhausts 70 and 72 were arranged in an asymmetric configuration about their respective coater units 62 and 64. In addition the coating station 59 had two discharge units 31 and 32 each with opening 50. The distance between the openings 74 and 76, 76 and 78, 80 and 82, 84 and 86 was about 2-3/4 inches (7.08 centimeters). The distance between the openings 80 and 78, and between 84 and 82 was about 5-1/2 inches (14.0 centimeters).

To effect the desired change in composition of the coating, different chemical feed rate ranges are required in each of the coating units 61, 62 and 64. The chemical concentrations required to produce the desired compositional change are also a function of the speed of the glass ribbon. Examples of typical setpoints are given in Table 3. In each of these cases the carrier gas was air, maintained at a temperature of about 320°F (160°C). The total gas flow of the discharge units 31 and 32 was held at about 500 standard liters per minute. The coating station 59 was spaced about 0.22 inches (0.59 centimeter) above the moving glass ribbon. The extended region of predominantly tin oxide was deposited at the coating station 60 using the teachings of U.S. Patent No. 4,853,257.

The equation ( $\sqrt{a^2 + b^2}$ ) usually used by those skilled in the art to quantify the observability of color of an object is discussed by Hunter in Food Technology, Vol. 32, pages 100-105, 1967 and in The Measurement of Appearance, Wiley and Sons, New York, 1975. A coated glass product having a Hunter value of 12 or less is considered to exhibit no appreciable observable color. Listed in Table 3 under the

column entitled Color Saturation Index is the measured Hunter value for the samples. As can be seen, all the samples had a color saturation index below 12.

Table 3

5

|  |          | MBTC          | MBTC          | MBTC          | TEOS          | TEOS          | TEOS          |
|--|----------|---------------|---------------|---------------|---------------|---------------|---------------|
|  | Sample   | Unit 61       | Unit 62       | Unit 64       | Unit 61       | Unit 62       | Cell 64       |
|  | <u>#</u> | <u>mole %</u> | <u>mole %</u> | <u>mole %</u> | <u>mole %</u> | <u>mole %</u> | <u>mole %</u> |

|    |   |       |       |       |       |       |       |
|----|---|-------|-------|-------|-------|-------|-------|
| 10 | 1 | 0.280 | 0.190 | 0.490 | 0.050 | 0.050 | 0.020 |
|    | 2 | 0.290 | 0.300 | 0.600 | 0.100 | 0.160 | 0.300 |
|    | 3 | 0.350 | 0.200 | 0.940 | 0.300 | 0.300 | 0.270 |
|    | 4 | 0.400 | 0.200 | 0.940 | 0.300 | 0.300 | 0.330 |
|    | 5 | 0.600 | 0.758 | 0.790 | 0.390 | 0.400 | 0.350 |
| 15 | 6 | 0.500 | 0.600 | 1.200 | 0.265 | 0.300 | 0.100 |

MBTC means monobutyltintrichloride

TEOS means tetraethoxysilane

20

|  |          | TEP           | TEP           | TEP           | WATER         | WATER         | WATER         |
|--|----------|---------------|---------------|---------------|---------------|---------------|---------------|
|  | Sample   | Unit 61       | Unit 62       | Unit 64       | Unit 61       | Unit 62       | Unit 64       |
|  | <u>#</u> | <u>mole %</u> | <u>mole %</u> | <u>mole %</u> | <u>mole %</u> | <u>mole %</u> | <u>mole %</u> |

|    |   |       |       |       |       |       |       |
|----|---|-------|-------|-------|-------|-------|-------|
| 25 | 1 | 0.300 | 0.100 | 0.025 | 0.170 | 0.600 | 0.600 |
|    | 2 | 0.280 | 0.110 | 0.039 | 0.180 | 0.330 | 0.630 |
|    | 3 | 0.280 | 0.120 | 0.070 | 0.150 | 0.610 | 0.370 |
|    | 4 | 0.280 | 0.100 | 0.050 | 0.150 | 0.610 | 0.370 |
|    | 5 | 0.266 | 0.120 | 0.066 | 0.150 | 0.180 | 0.640 |
| 30 | 6 | 0.400 | 0.300 | 0.288 | 0.400 | 1.000 | 1.000 |

TEP means triethyphosphite

|    |        | GLASS       | GLASS       | COLOR      | Gradient  | Tin Oxide |
|----|--------|-------------|-------------|------------|-----------|-----------|
|    | Sample | TEMPERATURE | SPEED       | SATURATION | Thickness | Thickness |
| 5  | #      | °F          | inches/min. | INDEX      | Å         | Å         |
|    | 1      | 1230        | 340         | 5.0        | 1200      | 4000      |
|    | 2      | 1234        | 340         | 5.0        | 1100      | 4000      |
|    | 3      | 1194        | 340         | 2.3        | 1250      | 3700      |
| 10 | 4      | 1200        | 340         | 3.6        | 1150      | 3650      |
|    | 5      | 1190        | 490         | 8.9        | 850       | 1750      |
|    | 6      | 1200        | 700         | 4.6        | 1000      | 1700      |

Although several embodiments of the present invention have  
15 been described and illustrated, it will be apparent to those  
skilled in the art that various changes and further  
modifications may be made therein without departure from the  
spirit of the invention or from the scope of the appended  
claims.

WE CLAIM:

1. In a coating composition vapor for the pyrolytic deposition of silicon dioxide comprising a carrier gas, a source of oxygen and a silicon compound, the improvement wherein said composition comprises at least one silicon compound comprising:



wherein  $\text{R}_1$  is selected from the group consisting of alkyl and substituted alkyl radicals having from one to 10 carbon atoms; alkenyl and substituted alkenyl radicals having from 2 to 10 carbon atoms; alkynyl and substituted alkynyl radicals having from 2 to 10 carbon atoms; aryl, aralkyl, substituted aryl and substituted aralkyl radicals having from 6 to 11 carbon atoms; and

$\text{R}_2$  is selected from the group consisting of hydrogen; halogen; alkenyl and substituted alkenyl radicals having from 2 to 10 carbon atoms; halogenated alkyl and perhalogenated alkyl radicals having one to 10 carbon atoms; alkynyl and substituted alkynyl radicals having from 2 to 10 carbon atoms.

2. The composition of claim 1, wherein said alkyl or substituted alkyl radicals have from 1 to 4 carbon atoms; said alkenyl or substituted alkenyl radicals have from 2 to 4 carbon atoms; said alkynyl or substituted alkynyl radicals have from 2 to 4 carbon atoms; and said aryl, aralkyl, substituted aryl and substituted aralkyl radicals have from 6 to 9 carbon atoms.

3. The composition of claim 2, wherein said alkyl or substituted alkyl radicals are selected from the group consisting of  $-\text{CH}_3$ ,  $-\text{CH}_2\text{CH}_2\text{CH}_3$ ,  $-\text{CH}_2\text{CH}_2\text{-OH}$ ,  $-\text{CCl}_3$ ,  $-\text{CH}_2\text{CHClCH}_3$  and  $-\text{CH}_2\text{CCl}_2\text{CCl}_3$ ; said alkenyl or substituted alkenyl radicals are selected from the group consisting of  $-\text{CH=CHCH}_3$  and  $-\text{CH=CH}_2$ ; said alkynyl or substituted alkynyl radicals are selected from the group consisting of  $-\text{C}\equiv\text{C-CH}_3$  and  $-\text{C}\equiv\text{CH}$ ; and said aryl, aralkyl, substituted aryl or substituted aralkyl radicals are selected from the group consisting of  $-\text{C}_6\text{H}_5$  and  $-\text{C}_6\text{H}_4\text{CH}_3$ .

4. The coating composition of claim 1, wherein said halogen is chlorine; said alkenyl or substituted alkenyl radical comprises from 2 to 4 carbon atoms; said halogenated, perhalogenated or substituted alkyl radical comprises from 1 to 4 carbon atoms; and said alkynyl or substituted alkynyl radical comprises from 6 to 9 atoms.

5. The coating composition of claim 4, wherein said alkenyl or substituted alkenyl radical is selected from the group consisting of  $-\text{CH=CHCH}_3$  and  $-\text{CH=CH}_2$ ; said halogenated, perhalogenated or substituted alkyl radical is selected from the group consisting of  $-\text{CCl}_3$ ,  $-\text{CH}_2\text{CHClCH}_3$  and  $-\text{CH}_2\text{CCl}_2\text{CCl}_3$ ; and said alkynyl or substituted alkynyl radical is selected from the group consisting of  $-\text{C}\equiv\text{CH}_3$ ,  $-\text{C}\equiv\text{C-CH}_3$  and  $-\text{CH}_2\text{C}\equiv\text{CH}$ .



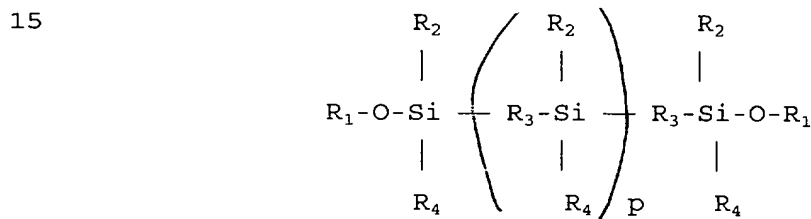
6. A coating composition vapor according to claim 1, wherein said compound has the formula



10            wherein  $R_3$  and  $R_4$  are independently selected from the group consisting of alkyl and substituted alkyl radicals having from one to 10 carbon atoms; alkenyl and substituted alkenyl radicals having from 2 to 10 carbon atoms; alkynyl and substituted alkynyl radicals having from 2 to 10 carbon atoms; 15 aryl, aralkyl, substituted aryl and substituted aralkyl radicals having from 6 to 11 carbon atoms; hydrogen; halogen; -CN; -OCN; phosphine; alkylphosphines and dialkylphosphines wherein the alkyl radical has from 1 to 10 carbon atoms.

20            7. The coating composition of claim 6, wherein said compound is selected from the group consisting of trichloroethoxysilane, trichloropropoxysilane, ethoxysilane, chloroethoxysilane, dichloroethoxysilane, tri- (trichloromethyl)ethoxysilane, di- 25 (pentachloroethyl)ethoxysilane, di- (trichloromethyl)ethoxysilane, tri- (pentachloroethyl)ethoxysilane, pentachloroethylethoxysilane, trichloromethylethoxysilane, trichloromethylpropoxysilane, trichloromethyldichloroethoxysilane, 30 pentachloroethylchloroethoxysilane, dimethylmethoxysilane, dimethylchloromethoxysilane, trichloromethoxysilane, tetramethyldisiloxane, tetramethyldichlorodisiloxane.

8. A coating composition vapor according to claim 1, wherein said compound has the formula selected from the group consisting of:



wherein m is from 2 to 7; p is from 0 to 7; R<sub>3</sub> is independently selected from the group consisting of

-S-; -P- and -N-; -O-; and -(CH<sub>2</sub>)<sub>n</sub>

wherein n is 1 to 10; and R<sub>4</sub> is independently selected from the group consisting of alkyl and substituted alkyl functional groups having from one to 10 carbon atoms; alkenyl and substituted alkenyl functional groups having from 2 to 10 carbon atoms; alkynyl and substituted alkynyl functional groups having from 2 to 10 carbon atoms; aryl and substituted aryl functional groups having from 6 to 11 carbon atoms; hydrogen; halogen; -CN; -OCN; phosphine and substituted phosphines.

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16. The composition of claim 9, wherein the accelerant is a compound of a metal selected from the group consisting of manganese, cobalt, iron, nickel, copper, zinc, strontium, cadmium, lead, aluminum, scandium, chromium, gallium, arsenic, yttrium, indium, antimony, bismuth, titanium, germanium, zirconium, tin.

17. The composition of claim 16, wherein said  
accelerant is selected from the group consisting of metal  
organic compounds, metal halide compounds and metal compounds  
5 containing a combination of organic and halogen functional  
groups.

18. The composition of claim 9, wherein said  
accelerant is a Lewis Acid.

10

19. The composition of claim 18, wherein said  
Lewis acid is selected from the group consisting of  
trifluoroacetic acid, hydrochloric acid, acetic acid and  
formic acid.

15

20. The composition of claim 9, wherein said  
accelerant is a Lewis Base.

21. The composition of claim 20 wherein said Lewis  
20 base is selected from the group consisting of NaOH, NaF,  
methanol, methyl ether and ethylthioether.

22. The composition of claim 9, wherein said  
accelerant is water.

25

23. The composition according to claim 1, further  
comprising a metal-containing compound vapor comprising a  
metal, M, other than silicon.

24. The composition of claim 23, wherein said  
30 compound has the formula  $M(R_{22})_q$ , wherein q is the valence of M  
and  $R_{22}$  is selected from the group consisting of organic and  
halide radicals.

25. The composition of claim 24, wherein M is selected from the group consisting of tin, titanium, tungsten and antimony.

5           26. The composition according to claim 25, wherein said metal-containing compound is an organotin compound.

27. The composition according to claim 26, wherein said tin compound has the structural formula  $\text{Sn}(\text{R}_{22})_4$  wherein  
10 each  $\text{R}_{22}$  is independently selected from the group consisting of halogen, alkyl, aryl and acetylacetonate radicals.

28. The composition according to claim 27, wherein at least one  $\text{R}_{22}$  is a halogen and at least one  $\text{R}_{22}$  is an alkyl  
15 radical having from 1 to 10 carbon atoms.

29. The composition according to claim 28, wherein at least one  $\text{R}_{22}$  is chloride and at least one  $\text{R}_{22}$  is an alkyl  
radical having from 1 to 4 carbon atoms.

20           30. The composition according to claim 29, wherein said organotin compound is monobutyltin trichloride.

31. The composition of claim 23, further  
25 comprising an accelerant to increase the deposition rate of silicon oxide.

32. The composition of claim 31, wherein said accelerant is selected from the group consisting of water;  
30 ozone; Lewis acid; Lewis basis; trivalent compounds of nitrogen, phosphorus and boron; tetravalent compounds of sulfur and selenium; pentavalent compounds of phosphorus; and

5

Attorney's Case No. \_\_\_\_\_

DECLARATION AND POWER OF ATTORNEY  
Continuation-in-part Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention COMPOUNDS AND COMPOSITIONS FOR COATING GLASS WITH SILICON OXIDE

the specification of which

(check one) [X] is attached hereto.

[ ] was filed on \_\_\_\_\_ as  
Application Serial No. \_\_\_\_\_  
and was amended on \_\_\_\_\_  
(if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of the invention described in this application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

|                          |                          |                                |
|--------------------------|--------------------------|--------------------------------|
| <u>08/264,816</u>        | <u>June 23, 1994</u>     | <u>pending</u>                 |
| (Application Serial No.) | (Filing Date)            | (Status)                       |
|                          |                          | (patented, pending, abandoned) |
| <u>08/017,930</u>        | <u>February 16, 1993</u> | <u>patented</u>                |
| (Application Serial No.) | (Filing Date)            | (Status)                       |
|                          |                          | (patented, pending, abandoned) |

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Date

Residence: Allegheny County, Springdale, Pennsylvania

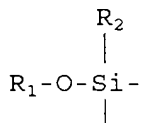
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# ABSTRACT OF THE INVENTION

Silicon compounds useful as coating reactants for the chemical vapor deposition of silicon oxide are disclosed, along with compounds useful as accelerants to increase the deposition rate of silicon oxide. The silicon-containing precursor comprises the structural formula



wherein  $R_1$  is an alkyl, alkenyl, alkynyl or aryl radical which may be substituted, and  $R_2$  is a functional group which increases the reactivity of the silicon compound by withdrawing electron density away from the silicon atom, such as hydrogen, halogen, alkenyl, alkynyl, halogenated alkyl and perhalogenated alkyl radicals. The accelerant is a compound selected to take advantage of the partial positive charge on the silicon atom. Such accelerant compounds include Lewis acids and bases; water; ozone; trivalent compounds of nitrogen, boron and phosphorus; tetravalent compounds of sulfur and selenium; pentavalent compounds of phosphorus and a variety of metal compounds. Also disclosed are compositions including an additional metal-containing coating precursor, such as an organotin compound, to deposit another metal oxide along with silicon oxide.

FIG. 1

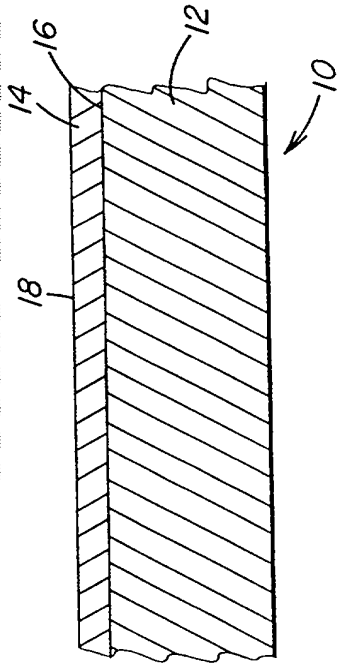


FIG. 2

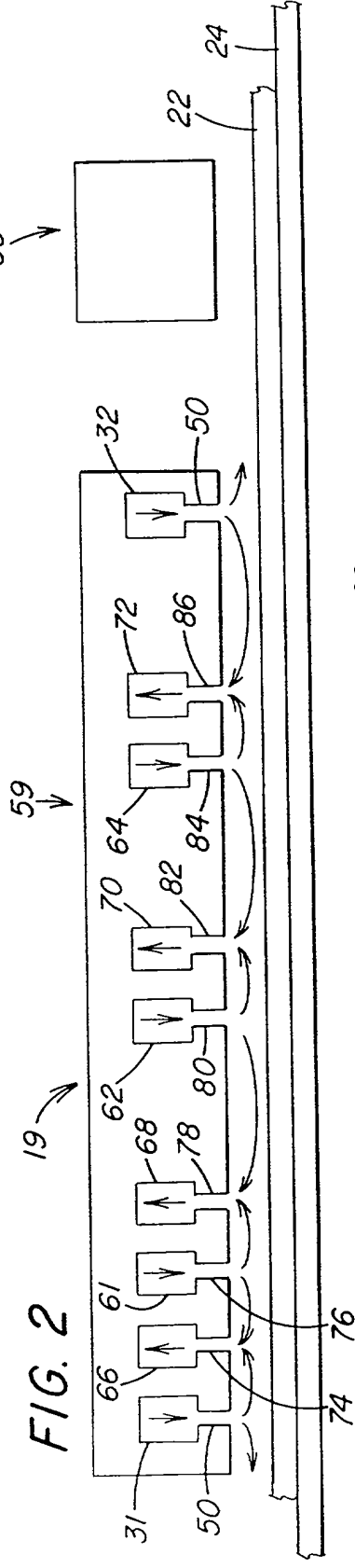
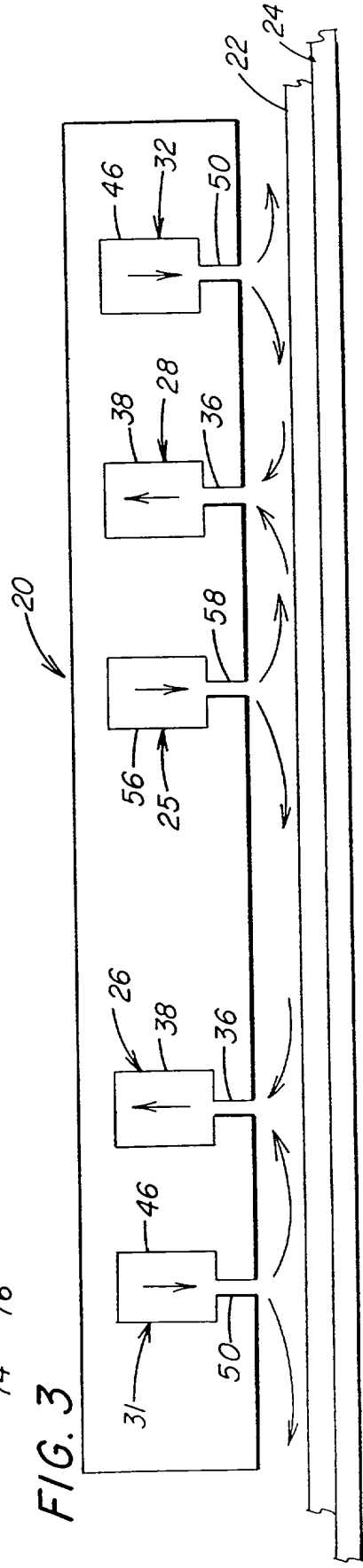


FIG. 3



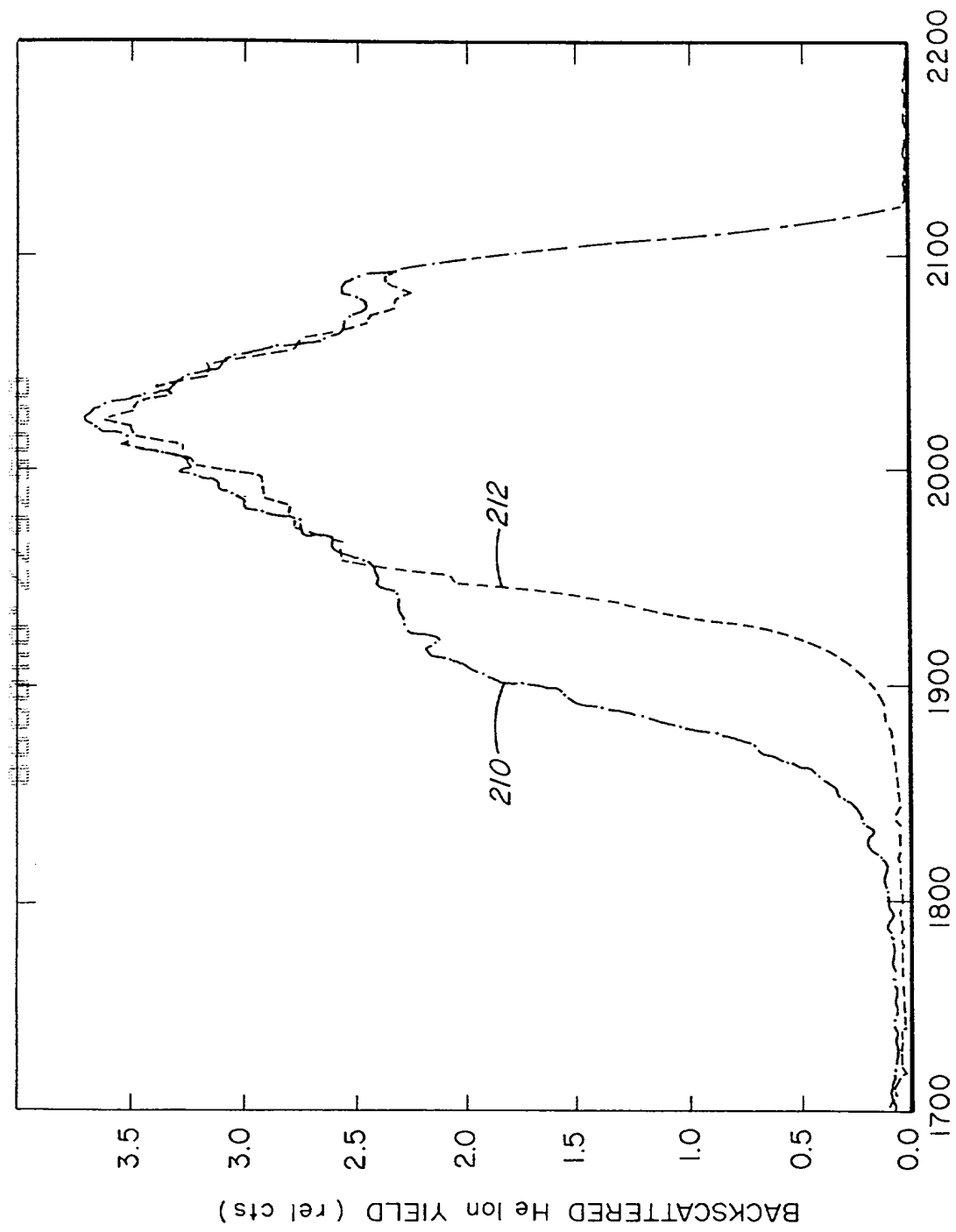


FIG. 4

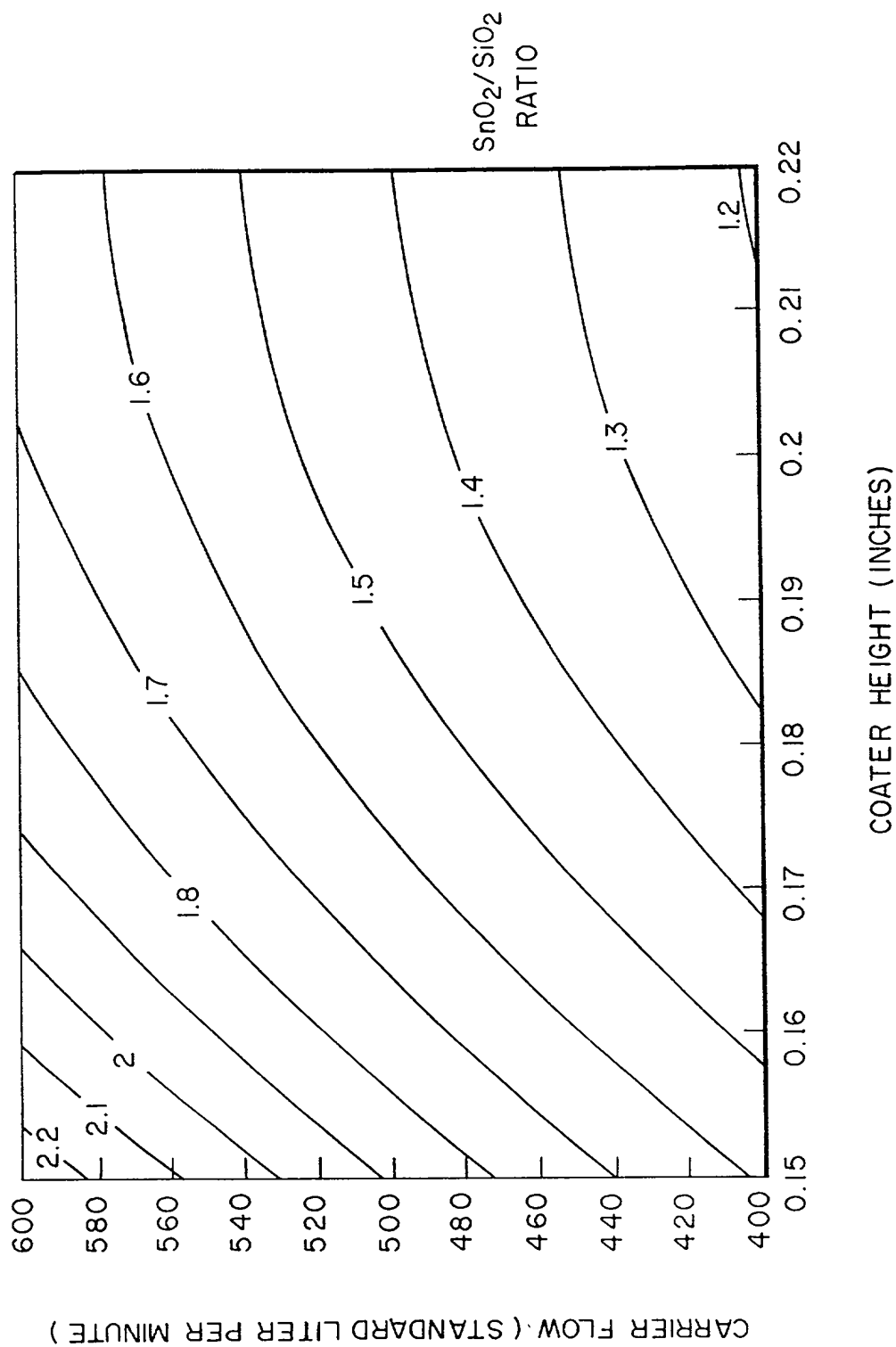


FIG. 5

Figure 1 shows the results of the first two steps of the analysis. The first step was to identify the variables that were significantly associated with the outcome variable. The second step was to identify the variables that were significantly associated with the outcome variable, controlling for the other variables in the model. The results of the first step are shown in Table 1. The results of the second step are shown in Table 2. The results of the third step are shown in Table 3. The results of the fourth step are shown in Table 4. The results of the fifth step are shown in Table 5. The results of the sixth step are shown in Table 6. The results of the seventh step are shown in Table 7. The results of the eighth step are shown in Table 8. The results of the ninth step are shown in Table 9. The results of the tenth step are shown in Table 10. The results of the eleventh step are shown in Table 11. The results of the twelfth step are shown in Table 12. The results of the thirteenth step are shown in Table 13. The results of the fourteenth step are shown in Table 14. The results of the fifteenth step are shown in Table 15. The results of the sixteenth step are shown in Table 16. The results of the seventeenth step are shown in Table 17. The results of the eighteenth step are shown in Table 18. The results of the nineteenth step are shown in Table 19. The results of the twentieth step are shown in Table 20. The results of the twenty-first step are shown in Table 21. The results of the twenty-second step are shown in Table 22. The results of the twenty-third step are shown in Table 23. The results of the twenty-fourth step are shown in Table 24. The results of the twenty-fifth step are shown in Table 25. The results of the twenty-sixth step are shown in Table 26. The results of the twenty-seventh step are shown in Table 27. The results of the twenty-eighth step are shown in Table 28. The results of the twenty-ninth step are shown in Table 29. The results of the thirtieth step are shown in Table 30. The results of the thirty-first step are shown in Table 31. The results of the thirty-second step are shown in Table 32. The results of the thirty-third step are shown in Table 33. The results of the thirty-fourth step are shown in Table 34. The results of the thirty-fifth step are shown in Table 35. The results of the thirty-sixth step are shown in Table 36. The results of the thirty-seventh step are shown in Table 37. The results of the thirty-eighth step are shown in Table 38. The results of the thirty-ninth step are shown in Table 39. The results of the fortieth step are shown in Table 40. The results of the forty-first step are shown in Table 41. The results of the forty-second step are shown in Table 42. The results of the forty-third step are shown in Table 43. The results of the forty-fourth step are shown in Table 44. The results of the forty-fifth step are shown in Table 45. The results of the forty-sixth step are shown in Table 46. The results of the forty-seventh step are shown in Table 47. The results of the forty-eighth step are shown in Table 48. The results of the forty-ninth step are shown in Table 49. The results of the fiftieth step are shown in Table 50. The results of the fifty-first step are shown in Table 51. The results of the fifty-second step are shown in Table 52. The results of the fifty-third step are shown in Table 53. The results of the fifty-fourth step are shown in Table 54. The results of the fifty-fifth step are shown in Table 55. The results of the fifty-sixth step are shown in Table 56. The results of the fifty-seventh step are shown in Table 57. The results of the fifty-eighth step are shown in Table 58. The results of the fifty-ninth step are shown in Table 59. The results of the sixtieth step are shown in Table 60. The results of the sixty-first step are shown in Table 61. The results of the sixty-second step are shown in Table 62. The results of the sixty-third step are shown in Table 63. The results of the sixty-fourth step are shown in Table 64. The results of the sixty-fifth step are shown in Table 65. The results of the sixty-sixth step are shown in Table 66. The results of the sixty-seventh step are shown in Table 67. The results of the sixty-eighth step are shown in Table 68. The results of the sixty-ninth step are shown in Table 69. The results of the seventieth step are shown in Table 70. The results of the seventy-first step are shown in Table 71. The results of the seventy-second step are shown in Table 72. The results of the seventy-third step are shown in Table 73. The results of the seventy-fourth step are shown in Table 74. The results of the seventy-fifth step are shown in Table 75. The results of the seventy-sixth step are shown in Table 76. The results of the seventy-seventh step are shown in Table 77. The results of the seventy-eighth step are shown in Table 78. The results of the seventy-ninth step are shown in Table 79. The results of the eightieth step are shown in Table 80. The results of the eighty-first step are shown in Table 81. The results of the eighty-second step are shown in Table 82. The results of the eighty-third step are shown in Table 83. The results of the eighty-fourth step are shown in Table 84. The results of the eighty-fifth step are shown in Table 85. The results of the eighty-sixth step are shown in Table 86. The results of the eighty-seventh step are shown in Table 87. The results of the eighty-eighth step are shown in Table 88. The results of the eighty-ninth step are shown in Table 89. The results of the ninetieth step are shown in Table 90. The results of the ninety-first step are shown in Table 91. The results of the ninety-second step are shown in Table 92. The results of the ninety-third step are shown in Table 93. The results of the ninety-fourth step are shown in Table 94. The results of the ninety-fifth step are shown in Table 95. The results of the ninety-sixth step are shown in Table 96. The results of the ninety-seventh step are shown in Table 97. The results of the ninety-eighth step are shown in Table 98. The results of the ninety-ninth step are shown in Table 99. The results of the hundredth step are shown in Table 100.

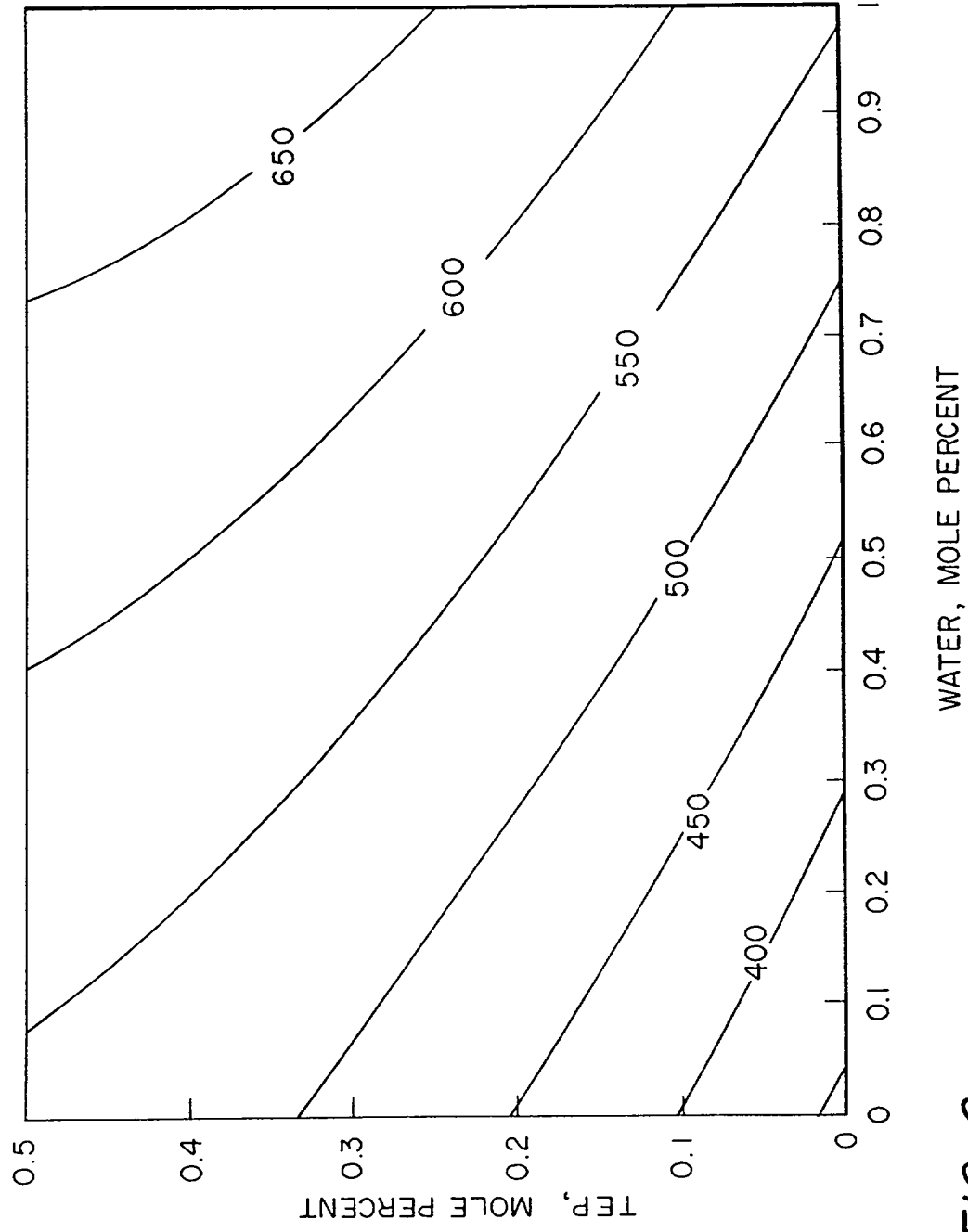


FIG. 6

**AMENDMENT TRANSMITTAL LETTER (Large Entity)**Applicant(s): **George A. Neuman et al.**

Docket No.

**1048D2**Serial No.  
to be assigned

Filing Date

Examiner  
**D. Brunsman**Group Art Unit  
**1108**Invention: **COMPOUNDS AND COMPOSITIONS FOR COATING GLASS WITH SILICON OXIDE****TO THE ASSISTANT COMMISSIONER FOR PATENTS:**

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

**CLAIMS AS AMENDED**

|  | CLAIMS REMAINING<br>AFTER AMENDMENT | HIGHEST #<br>PREV. PAID FOR | NUMBER EXTRA<br>CLAIMS PRESENT | RATE    | ADDITIONAL<br>FEE |
|--|-------------------------------------|-----------------------------|--------------------------------|---------|-------------------|
| TOTAL CLAIMS   | 14 -                                | 20 =                        | 0 x                            | \$22.00 | \$0.00            |
| INDEP. CLAIMS  | 1 -                                 | 3 =                         | 0 x                            | \$82.00 | \$0.00            |
| Multiple Dependent Claims (check if applicable) <input type="checkbox"/> |                                     |                             |                                |         | \$0.00            |
| TOTAL ADDITIONAL FEE FOR THIS AMENDMENT                                  |                                     |                             |                                |         | \$0.00            |

- ☒ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. \_\_\_\_\_ in the amount of \_\_\_\_\_  
A duplicate copy of this sheet is enclosed.
- ☐ A check in the amount of \_\_\_\_\_ to cover the filing fee is enclosed.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. **16-2025**  
A duplicate copy of this sheet is enclosed.
- ☒ Any additional filing fees required under 37 C.F.R. 1.16.
- ☒ Any patent application processing fees under 37 CFR 1.17.

  
SignatureDated: **April 9, 1998****DONALD C. LEPIANE, Esq.**

Registration No. 25,996

Attorney for Applicant

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Express Mail Label No. EM276273469US

Pittsburgh, Pennsylvania

CC:

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: :  
George A. Neuman et al. : PATENT APPLICATION  
Serial No. : Group Art Unit: 1108  
Filed: : Examiner: D. Brunsman  
For: COMPOUNDS AND COMPOSITIONS FOR : Atty. Docket No. 1048D2  
COATING GLASS WITH SILICON OXIDE :  
.....:

PRELIMINARY AMENDMENT

Assistant Commissioner of Patents  
Washington, D.C.

Sir:

Please amend the above-identified application.

INVENTORSHIP

Delete the name of "Patricia Ruzakowski Athey" as an inventor and add the name of --David E. Lecocq-- as an inventor.

IN THE SPECIFICATION

Page 1, line 5, after "This" insert --application is a division of U.S. Patent Application Serial No. 08/678,252 filed July 11, 1996, which is a division of U.S. Patent Application Serial No. 08/472,589 filed June 7, 1995, now U.S. Patent No. 5,599,387 which-- and

line 6, after "1994," insert --now U.S. Patent No. 5,464,657,".

IN THE CLAIMS

Cancel claim 1 and add the following new claims:

--33. An article comprising:

a substrate, and

a film over a surface of the substrate, the film comprising one or more metal oxides and an accelerant.--

--34. The article of claim 33, wherein said metal oxide is selected from the group of tin oxide, germanium oxide, titanium oxide, aluminum oxide, zirconium oxide, zinc oxide, indium oxide, cadmium oxide, tungsten oxide, vanadium oxide, chromium oxide, molybdenum oxide, nickel oxide, and tantalum oxide.--

--35. The article of claim 33, wherein said accelerant is selected from the group consisting of phosphites, borates, water, alkyl phosphine, borane derivatives and ozone.--

--36. The article of claim 33, wherein said accelerant is triethylphosphite.--

--37. The article of claim 33, further comprising a silicon oxide.--

--38. The article of claim 33, wherein said film is amorphous.--

--39. The article of claim 33, wherein the substrate is glass.--

--40. The article of claim 33, wherein the film has a refractive index which changes continuously.--

--41. The article of claim 33, wherein the film comprises a plurality of layers.--

--42. The article of claim 41, wherein each layer contains a mixture of tin and silicon oxides.--

--43. The article of claim 42, wherein each layer contains a concentration of tin oxide and silicon oxide different from an adjacent layer.--

--44. The article of claim 33, wherein the accelerant is present in an amount of up to about 0.76 mol. percent.--



--45. The article of claim 33, wherein the accelerant is present in an amount of from about 0.15 mol. percent to about 0.76 mol. percent.--

--46. The article of claim 33, wherein the accelerant is present in an amount of from about 0.36 mol. percent to about 0.76 mol. percent.--

**REMARKS**

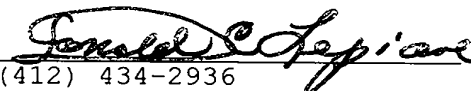
During the prosecution of U.S. Patent Application Serial No. 08/678,252 of which this application is a divisional, the inventorship was amended by deleting Patricia Ruzakowski Athey and inserting David E. Lecocq. The inventorship of this application is amended to be consistent therewith.

Claims 33-46 are similar, if not identical, to claims of U.S. Patent Application Serial No. 08/544,212 filed October 17, 1995, which is a reissue of U.S. Patent No. 5,401,385 and are similar to claims 71-81 and 85-87 of U.S. Patent Application Serial No. 08/678,252 of which the instant application is a divisional. In U.S. Patent Application Serial No. 08/628,252, claims 71-81 and 85-87 were Group III of the restriction.

Based on the foregoing, applicants respectfully request admission and consideration of the above claims.

Respectfully submitted,

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Attorney of Record

  
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Pittsburgh, Pennsylvania  
April 9, 1998